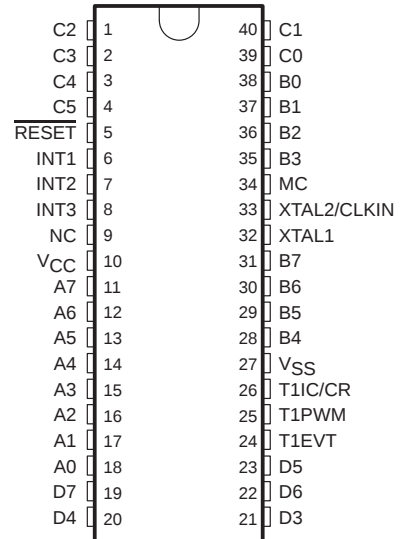
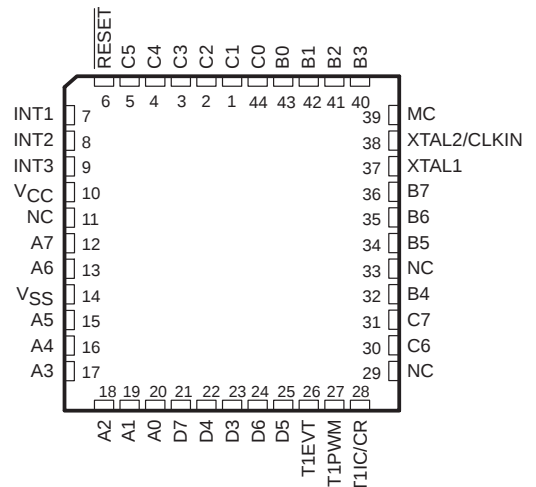


- **CMOS/EEPROM/EPROM Technologies on a Single Device**
 - Mask-ROM Devices for High-Volume Production
 - One-Time-Programmable (OTP) EPROM Devices for Low-Volume Production
 - Reprogrammable EPROM Devices for Prototyping Purposes
- **Internal System Memory Configurations**
 - On-Chip Program Memory Versions
 - ROM: 4K Bytes
 - EPROM: 16K Bytes
 - Data EEPROM: 256 Bytes
 - Static RAM: 128 or 256 Bytes Usable as Registers
- **Flexible Operating Features**
 - Low-Power Modes: STANDBY and HALT
 - Commercial, Industrial, and Automotive Temperature Ranges
 - Clock Options
 - Divide-by-1 (2 MHz–5 MHz SYSCLK) PLL
 - Divide-by-4 (0.5 MHz–5 MHz SYSCLK)
 - Supply Voltage (V_{CC}) 5 V $\pm$ 10%
- **16-Bit General Purpose Timer**
 - Software Configurable as a 16-Bit Event Counter, or a 16-Bit Pulse Accumulator, or a 16-Bit Input Capture Functions, or Two Compare Registers, or a Self-Contained Pulse Width Modulation (PWM) Function
- **On-Chip 24-Bit Watchdog Timer**
 - EPROM/OTP Device: Standard Watchdog
 - Mask-ROM Devices: Hard Watchdog, Simple Counter, or Standard Watchdog
- **Flexible Interrupt Handling**
 - Two S/W Programmable Interrupt Levels
 - Global- and Individual-Interrupt Masking
 - Programmable Rising- or Falling-Edge Detect
 - Individual Interrupt Vectors
- **TMS370 Series Compatibility**
 - Register-to-Register Architecture
 - 256 General-Purpose Registers
 - 14 Powerful Addressing Modes
 - Instructions Upwardly Compatible With all TMS370 Devices

**N PACKAGE
(TOP VIEW)**



**FZ AND FN PACKAGES
(TOP VIEW)**



- **CMOS/Package/TTL Compatible I/O Pins**
 - 40-Pin Plastic Dual-In-Line Packages/ 32 Bidirectional Pins, 1 Input Pin
 - 44-Pin Plastic Leaded Chip Carrier (LCC) Packages/34 Bidirectional Pins, 1 Input Pin
- **Workstation/PC-Based Development System**
 - C Compiler and C Source Debugger
 - Real-Time In-Circuit Emulation
 - Extensive Breakpoint/Trace Capability
 - Multi-Window User Interface
 - Microcontroller Programmer



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**TEXAS
INSTRUMENTS**

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TMS370Cx8x 8-BIT MICROCONTROLLER

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Pin Descriptions

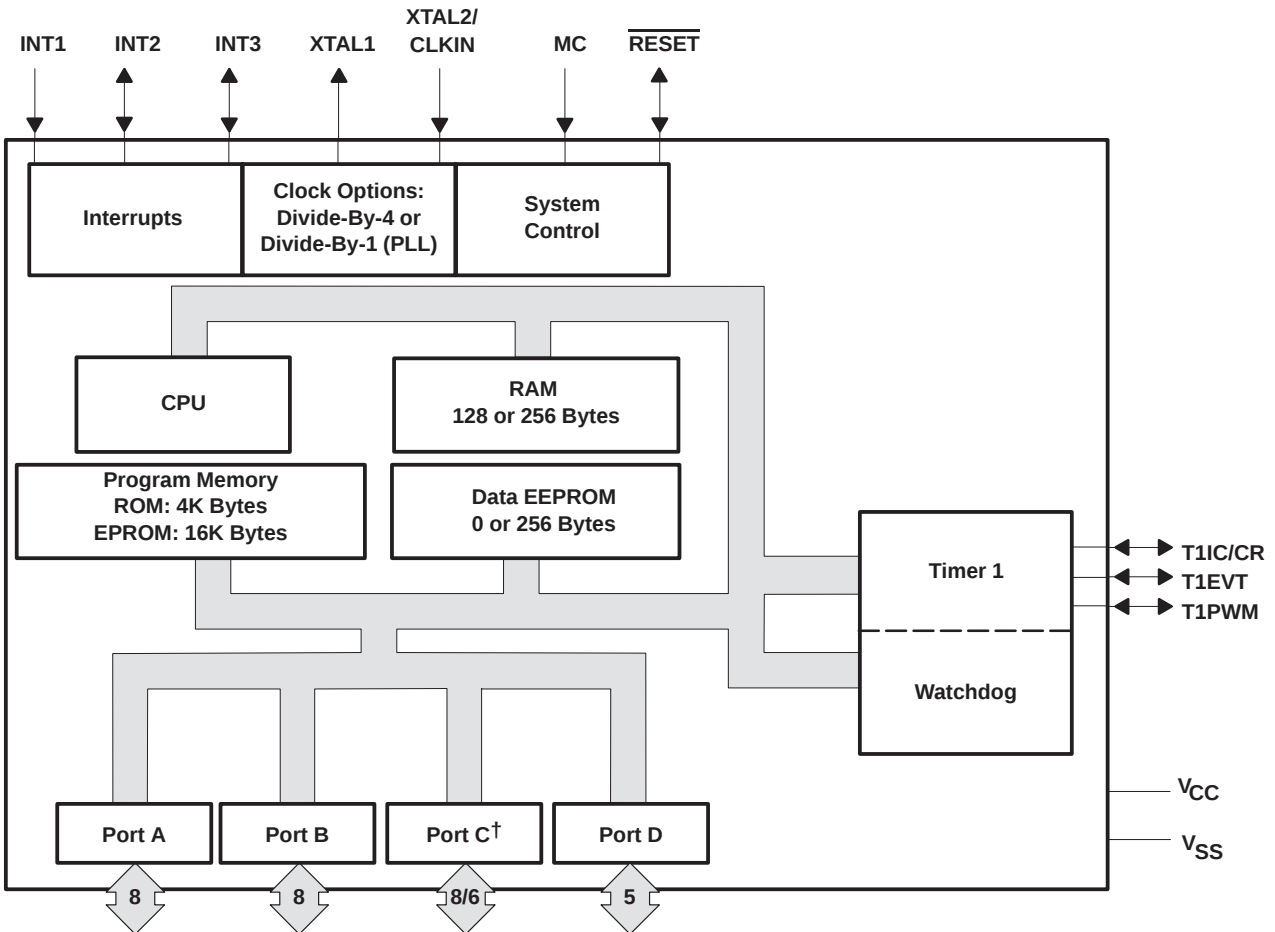
PINS			TYPE†	DESCRIPTION
NAME	PDIP (40)	LCC (44)		
A0 A1 A2 A3 A4 A5 A6 A7	18 17 16 15 14 13 12 11	20 19 18 17 16 15 13 12	I / O	Port A is a general-purpose bidirectional I/O port.
B0 B1 B2 B3 B4 B5 B6 B7	38 37 36 35 28 29 30 31	43 42 41 40 32 34 35 36	I / O	Port B is a general-purpose bidirectional I/O port.
C0 C1 C2 C3 C4 C5 C6 C7	39 40 1 2 3 4 — —	44 1 2 3 4 5 30 31	I / O	Port C is a general-purpose bidirectional I/O port.
D3 D4 D5 D6 D7	21 20 23 22 19	23 22 25 24 21	I / O	Port D is a general-purpose bidirectional I/O port. D3 is also configurable as SYSCLK.
INT1 INT2 INT3	6 7 8	7 8 9	I I / O I / O	External (non-maskable or maskable) interrupt/general-purpose input pin External maskable interrupt input/general-purpose bidirectional pin External maskable interrupt input/general-purpose bidirectional pin
T1IC/CR T1PWM T1EVT	26 25 24	28 27 26	I / O	Timer1 input capture/counter reset input pin / general-purpose bidirectional pin Timer1 PWM output pin/general-purpose bidirectional pin Timer1 external event input pin/general-purpose bidirectional pin
$\overline{\text{RESET}}$	5	6	I / O	System reset bidirectional pin: as input pin, $\overline{\text{RESET}}$ initializes the microcontroller; as open-drain output, $\overline{\text{RESET}}$ indicates that an internal failure was detected by the watchdog or oscillator fault circuit.
MC	34	39	I	Mode control pin; enables EEPROM write-protection override (WPO) mode, also EPROM V_{PP}
XTAL2/CLKIN XTAL1	33 32	38 37	I O	Internal oscillator crystal input/external clock source input Internal oscillator output for crystal
VCC	10	10		Positive supply voltage
VSS	27	14		Ground reference for digital logic
NC	9	11, 29, 33		These pins have no connection to the internal die.

† I = input, O = output



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functional block diagram



† For the 40-pin devices, there are only six pins for port C.

description

The TMS370C080, TMS370C380, TMS370C686, and SE370C686 devices are members of the TMS370 family of single-chip 8-bit microcontrollers. Unless otherwise noted, the term TMS370Cx8x refers to these devices. The TMS370 family provides cost-effective real-time system control through integration of advanced peripheral-function modules and various on-chip memory configurations.

The TMS370Cx8x family of devices is implemented using high-performance silicon-gate CMOS EPROM and EEPROM technologies. Low-operating power, wide operating temperature range, and noise immunity of CMOS technology coupled with the high performance and extensive on-chip peripheral functions make the TMS370Cx8x devices attractive for system designs for automotive electronics, industrial motors, computer peripheral controls, telecommunications, and consumer applications.

All TMS370Cx8x devices contain the following on-chip peripheral modules:

- One 24-bit general-purpose watchdog timer
- One 16-bit general-purpose timer with an 8-bit prescaler

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description (continued)

Table 1 provides a memory configuration overview of the TMS370Cx8x devices.

Table 1. Memory Configurations

DEVICE	PROGRAM MEMORY (BYTES)		DATA MEMORY (BYTES)		PACKAGES 44-PIN PLCC/CLCC, OR 40-PIN PDIP
	ROM	EPROM	RAM	EEPROM	
TMS370C080	4K	—	128	256	N – PDIP
TMS370C380A	4K	—	128	—	FN – PLCC
TMS370C686A	—	16K	256	—	FN – PLCC
SE370C686A [†]	—	16K	256	—	FZ – CLCC

[†] System evaluators and development are for use only in prototype environment and their reliability has not been characterized.

The suffix letter (A) appended to the device names shown in the device column of Table 1 and Table 2 indicates the configuration of the device. ROM or EPROM devices have different configurations as indicated in Table 2. ROM devices with the suffix letter A are configured through a programmable contact during manufacture. For a detailed description of the differences between the TMS370C080 and TMS370Cx8xA contact options (as indicated by the suffix letter nomenclature), refer to Appendix A of the *TMS370 Microcontroller Family User's Guide* (literature number SPNU127).

For a detailed description of the differences between the TMS370C080 and the TMS370Cx8xA contact options (as indicated by the suffix letter nomenclature), refer to Appendix A of the *TMS370 Microcontroller Family User's Guide* (literature number SPNU127).

Table 2. Suffix Letter Configuration

DEVICE [‡]	WATCHDOG TIMER	CLOCK	LOW-POWER MODE
EPROM A	Standard	Divide-by-4 (Standard oscillator)	Enabled
ROM A	Standard	Divide-by-4 or Divide-by-1 (PLL)	Enabled or disabled
	Hard		
	Simple		
ROM without A	Standard	Divide-by-4 (Standard oscillator)	Enabled

[‡] Refer to the "device numbering conventions" section for device nomenclature and to the "device part numbers" section for ordering.

The 4K bytes of mask-programmable ROM in the associated TMS370C380 device is replaced in the TMS370C686 with 16K bytes of EPROM. All other on-chip peripherals are identical. The one-time programmable (OTP) (TMS370C686) device and reprogrammable (SE370C686) device are available. The 4K-byte (TMS370C080) mask-programmable ROM device relies on the 68-pin (TMS370C758) development devices and a converter socket (part # TMDS37788OTP) for prototyping and programming purposes.

TMS370C686 OTP devices are available in plastic packages. This microcontroller is effective to use for immediate production updates for other members of the TMS370Cx8x family or for low-volume production runs when the mask charge or cycle time for the low-cost mask ROM devices is not practical.

The SE370C686 has a windowed ceramic package to allow reprogramming of the program EPROM memory during the development/prototyping phase of design. The SE370C686 devices allow quick updates to breadboards and prototype systems while iterating initial designs.

The TMS370Cx8x family provides two low-power modes (STANDBY and HALT) for applications where low-power consumption is critical. Both modes stop all CPU activity (that is, no instructions are executed). In the STANDBY mode, the internal oscillator and the general-purpose timer remain active. In the HALT mode, all device activity is stopped. The device retains all RAM data and peripheral configuration bits throughout both low-power modes.



description (continued)

The TMS370Cx8x features advanced register-to-register architecture that allows direct arithmetic and logical operations without requiring an accumulator (for example, ADD R24, R47; add the contents of register 24 to the contents of register 47 and store the result in register 47). The TMS370Cx8x family is fully instruction-set-compatible, providing easy transition between members of the TMS370 8-bit microcontroller family.

The TMS370Cx8x family provides the system designer with economical, efficient solutions to real-time control applications. The TMS370 family compact development tool (CDT™) solves the challenge of efficiently developing the software and hardware required to design the TMS370Cx8x into an ever-increasing number of complex applications. The application source code can be written in assembly and C languages, and the output code can be generated by the linker. The TMS370 family CDT development tool communicates through a standard RS-232-C interface with an existing personal computer. This allows the designer to use familiar personal computer editors and software utilities. Precise real-time, in-circuit emulation and extensive symbolic debug and analysis tools ensure efficient software and hardware implementation as well as reducing the time-to-market cycle.

The TMS370Cx8x family together with the TMS370 family CDT370, software tools, the SE370C686 and SE370C758 (FZ package) reprogrammable devices, comprehensive product documentation, and customer support provide a complete solution to the needs of the system designer.

central processing unit (CPU)

The CPU on the TMS370Cx8x device is the high-performance 8-bit TMS370 CPU module. The 'x8x implements an efficient register-to-register architecture that eliminates the conventional accumulator bottleneck. The complete 'x8x instruction map is shown in Table 15 in the TMS370Cx8x instruction set overview section.

The '370Cx8x CPU architecture provides the following components:

- CPU registers:
 - A stack pointer that points to the last entry in the memory stack
 - A status register that monitors the operation of the instructions and contains the global interrupt-enable bits
 - A program counter (PC) that points to the memory location of the next instruction to be executed
- A memory map that includes:
 - 128- or 256-byte general-purpose RAM that can be used for data memory storage, program instructions, general purpose register, or the stack
 - A peripheral file that provides access to all internal peripheral modules, system-wide control functions, and EEPROM/EPROM programming control
 - 256-byte EEPROM module, that provides in-circuit programmability and data retention in power-off conditions
 - 4K-byte ROM or 16K-byte EPROM program memory

central processing unit (CPU) (continued)

Figure 1 illustrates the CPU registers and memory blocks.

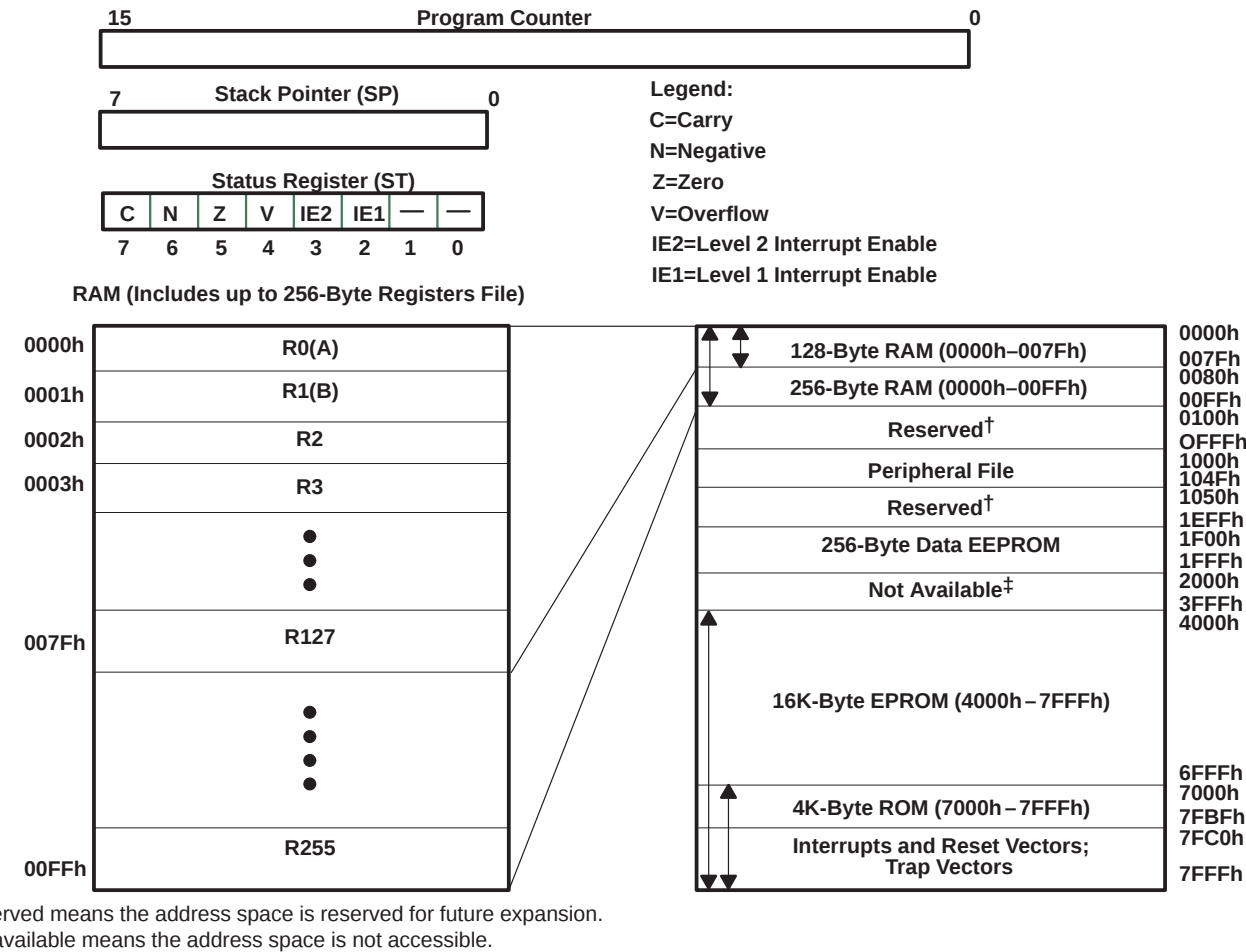


Figure 1. Programmer's Model

stack pointer (SP)

The SP is an 8-bit CPU register. Stack operates as a last-in, first-out, read/write memory. Typically, the stack is used to store the return address on subroutine calls as well as the status register (ST) contents during interrupt sequences.

The SP points to the last entry or top of the stack. The SP is incremented automatically before data is pushed onto the stack and decremented after data is popped from the stack. The stack can be placed anywhere in the on-chip RAM.

central processing unit (CPU) (continued)

status register

The ST monitors the operation of the instructions and contains the global interrupt-enable bits. The ST includes four status bits (condition flags) and two interrupt-enable bits.

- The four status bits indicate the outcome of the previous instruction; conditional instructions (for example, the conditional-jump instructions) use the status bits to determine program flow.
- The two interrupt-enable bits control the two interrupt levels.

The ST, status-bit notation, and status-bit definitions are shown in Table 3.

Table 3. Status Registers

7	6	5	4	3	2	1	0
C	N	Z	V	IE2	IE1	Reserved	Reserved
RW-0	RW-0	RW-0	RW-0	RW-0	RW-0		

R = read, W = write, 0 = value after reset

program counter (PC)

The contents of the PC point to the memory location of the next instruction to be executed. The PC consists of two 8-bit registers in the CPU: the program counter high (PCH), and the program counter low (PCL). These registers contain the most significant byte (MSbyte) and least significant byte (LSbyte) of a 16-bit address.

During reset, the contents of the reset vector (7FFEh, 7FFFh) are loaded into the PC. The PCH (MSbyte of the PC) is loaded with the contents of memory location 7FFEh, and the PCL (LSbyte of the PC) is loaded with the contents of memory location 7FFFh. Figure 2 shows this operation using an example value of 6000h as the contents of the reset vector.

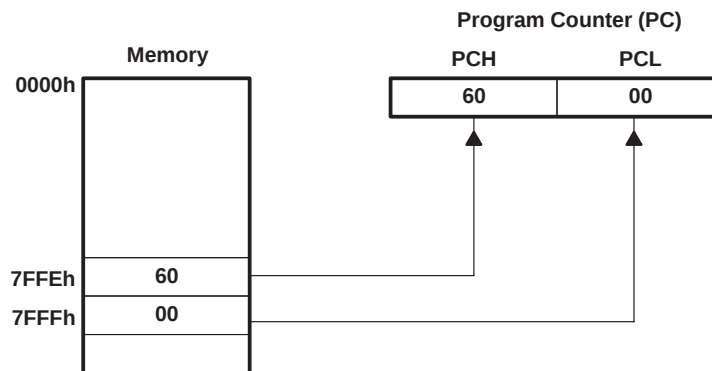


Figure 2. Program Counter After Reset

memory map

The TMS370Cx8x architecture is based on the Von Neuman architecture, in which the program memory and data memory share a common address space. All peripheral input/output is memory-mapped in this same common address space. As shown in Figure 3, the TMS370Cx8x provides memory-mapped RAM, ROM, data EEPROM, I/O pins, peripheral functions, and system-interrupt vectors.

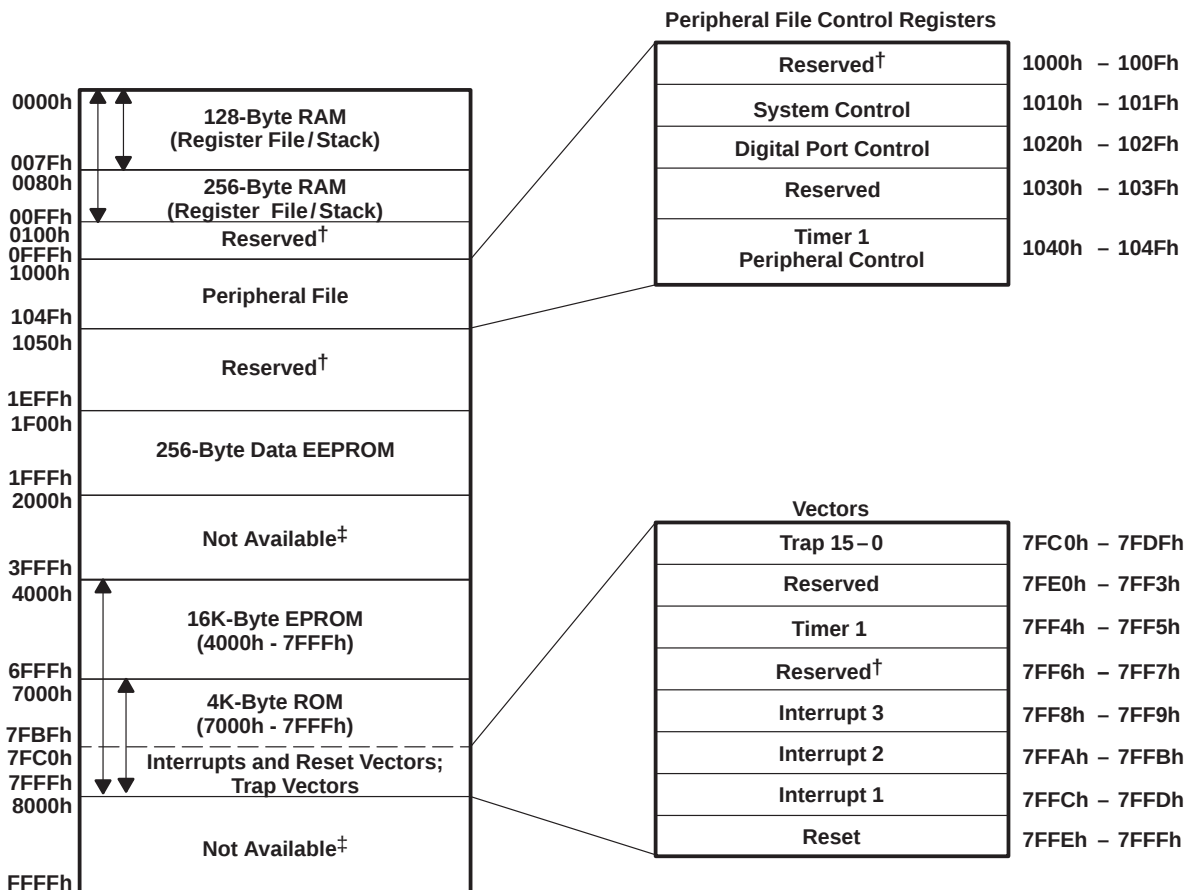
The peripheral file contains all I/O port control, peripheral status and control, EEPROM, EPROM, and system-wide control functions. The peripheral file consists of 256 contiguous addresses located from 1000h to 10FFh and is divided logically into 16 peripheral file frames of 16 bytes each. Each on-chip peripheral is

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TMS370Cx8x CPU (continued)

assigned to a separate frame through which peripheral control and data information is passed. The TMS370Cx8x has its on-chip peripherals and system control assigned to peripheral file frames 1 through 4, addresses 1010h through 104Fh.



† Reserved means that the address space is reserved for future expansion, means the address space is not accessible.

‡ Not available means that the address space is not accessible.

Figure 3. TMS370Cx8x Memory Map

RAM/register file (RF)

Locations within the RAM address space can serve as the RF, general-purpose read/write memory, program memory, or the stack instructions. The TMS370C080 and TMS370C380 contain 128 bytes of internal RAM memory mapped beginning at location 0000h (R0) and continuing through location 007Fh (R127), which is shown in Table 4 along with 'x86 devices.

Table 4. RAM Memory Map

	'x80	'x86
RAM size	128 bytes	256 bytes
Memory mapped	0000h–007Fh	0000h–00FFh

The first two registers, R0 and R1, are also called register A and B, respectively. Some instructions implicitly use register A or B; for example, the instruction load SP (LDSP) assumes that the value to be loaded into the stack pointer is contained in register B. Registers A and B are the only registers cleared on reset.

peripheral file (PF)

The TMS370Cx8x control registers contain all the registers necessary to operate the system and peripheral modules on the device. The instruction set includes some instructions that access the PF directly. These instructions designate the register by the number of the PF relative to 1000h, preceded by P0 for a hexadecimal designator or P for a decimal designator. For example, the system-control register 0 (SCCR0) is located at address 1010h; its peripheral file hexadecimal designator is P010, and its decimal designator is P16. Table 5 shows the TMS370Cx8x PF address map.

Table 5. TMS370Cx8x Peripheral File Address Map

ADDRESS RANGE	PERIPHERAL FILE DESIGNATOR	DESCRIPTION
1000h–100Fh	P000–P00F	Reserved
1010h–101Fh	P010–P01F	System and EPROM/EEPROM control registers
1020h–102Fh	P020–P02F	Digital I/O port control registers
1030h–103Fh	P030–P03F	Reserved
1040h–104Fh	P040–P04F	Timer 1 registers
1050h–10FFh	P050–P0FF	Reserved

data EEPROM

The TMS370C080 device, containing 256 bytes of data EEPROM, has a memory mapped beginning at location 1F00h and continuing through location 1FFFh. Writing to the data EEPROM module is controlled by the data EEPROM control register (DEECTL) and the write-protection register (WPR). Programming algorithm examples are available in the *TMS370 Family User's Guide* (literature number SPNU127) or the *TMS370 Family Data Manual* (literature number SPNS014B). The data EEPROM features include the following:

- Programming:
 - Bit-, byte-, and block-write/erase modes
 - Internal charge pump circuitry. No external EEPROM programming voltage supply is needed.
 - Control register: Data EEPROM programming is controlled by the data EEPROM control register (DEECTL) located in the PF frame beginning at location P01A. See Table 6.
 - In-circuit programming capability. There is no need to remove the device to program.
- Write-protection. Writes to the data EEPROM are disabled during the following conditions.
 - Reset. All programming of the data EEPROM module is halted.
 - Write-protection active. There is one write-protect bit per 32-byte EEPROM block.
 - Low-power mode operation
- Write-protection can be overridden by applying 12 V to MC.

Table 6. Data EEPROM and PROGRAM EPROM Control Registers Memory Map

ADDRESS	SYMBOL	NAME
P01A	DEECTL	Data EEPROM Control Register
P01B	—	Reserved
P01C	EPCTL	Program EPROM Control Register

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program EPROM[†]

The TMS370C686 device contains 16K bytes of EPROM memory, mapped beginning at location 4000h and continuing through location 7FFFh as shown in Figure 3. Reading the program EPROM modules is identical to reading other internal memory. During programming, the EPROM is controlled by the EPROM control register (EPCTL). The program EPROM module features include:

- Programming
 - In-circuit programming capability if V_{PP} is applied to MC
 - Control register EPROM programming is controlled by the EPROM control register (EPCTL) located in the peripheral file (PF) frame at location P01C as shown in Table 6.
- Write-protection writes to the program EPROM are disabled under the following conditions
 - Reset all programming to the EPROM module is halted
 - Low-power modes
 - 13 V not applied to MC

program ROM[†]

The program ROM consists of 4K bytes of mask-programmable read-only memory. The program ROM is used for permanent storage of data or instructions. Programming of the mask ROM is performed at the time of device fabrication.

system reset

The system-reset operation ensures an orderly start-up sequence for the TMS370Cx8x CPU-based device. There are up to three different actions that can cause the system to reset the device. Two of these actions are generated internally, while one (RESET pin) is controlled externally. These actions are as follows:

- Watchdog (WD) timer. A watchdog-generated reset occurs if an improper value is written to the WD key register, or if the re-initialization does not occur before the watchdog timer timeout. See the *TMS370 User's Guide* (literature number SPNU127) for more information.
- Oscillator reset. Reset occurs when the oscillator operates outside of the recommended operating range. See the *TMS370 User's Guide* (literature number SPNU127) for more information.
- External RESET pin. A low-level signal can trigger an external reset. To ensure a reset, the external signal should be held low for one SYSCLK cycle. Signals of less than one SYSCLK can generate a reset. See the *TMS370 User's Guide* (literature number SPNU127) for more information.

Once a reset source is activated, the external RESET pin is driven (active) low for a minimum of eight SYSCLK cycles. This allows the 'x8x device to reset external system components. Additionally, if a cold start (V_{CC} is off for several hundred milliseconds) condition or oscillator failure occurs, or the RESET pin is held low, then the reset logic holds the device in a reset state for as long as these actions are active.

After a reset, the program can check the oscillator-fault flag (OSC FLT FLAG, SCCR0.4), the cold-start flag (COLD START, SCCR0.7) and the watchdog reset (WD OVRFL INT FLAG, T1CTL2.5) to determine the source of the reset. A reset does not clear these flags. Table 7 depicts the reset sources.

[†] Memory addresses 7FE0h through 7FEBh are reserved for Texas Instruments Incorporated, and 7FF4h through 7FF5h along with 7FF8h through 7FFFh are reserved for interrupt and reset vectors. Trap vectors, used with TRAP0 through TRAP15 instructions, are located between addresses 7FC0h and 7DFh.

system reset (continued)

Table 7. Reset Sources

REGISTER	ADDRESS	PF	BIT NO.	CONTROL BIT	SOURCE OF RESET
SCCR0	1010h	P010	7	COLD START	Cold (power-up)
SCCR0	1010h	P010	4	OSC FLT FLAG	Oscillator out of range
T1CTL2	104Ah	P04A	5	WD OVRFL INT FLAG	Watchdog timer timeout

Once a reset is activated, the following sequence of events occurs:

1. The CPU registers are initialized: ST = 00h, SP = 01h (reset state).
2. Register A and B are initialized to 00h (no other RAM is changed).
3. The contents of the LSbyte of the reset vector (07FFh) are read and stored in the PCL.
4. The contents of the MSbyte of the reset vector (07FEh) are read and stored in the PCH.
5. Program execution begins with an opcode-fetch from the address pointed to the PC.

The reset sequence takes 20 SYSCLK cycles from the time the reset pulse is released until the first opcode fetch. During a reset, RAM contents (except for registers A and B) remain unchanged, and the module control register bits are initialized to their reset state.

interrupts

The TMS370 family software-programmable interrupt structure permits flexible on-chip and external interrupt configurations to meet real-time interrupt-driven application requirements. The hardware-interrupt structure incorporates two priority levels as shown in Figure 4. Interrupt level 1 has a higher priority than interrupt level 2. The two priority levels can be masked independently by the global interrupt mask bits (IE1 and IE2) of the ST.

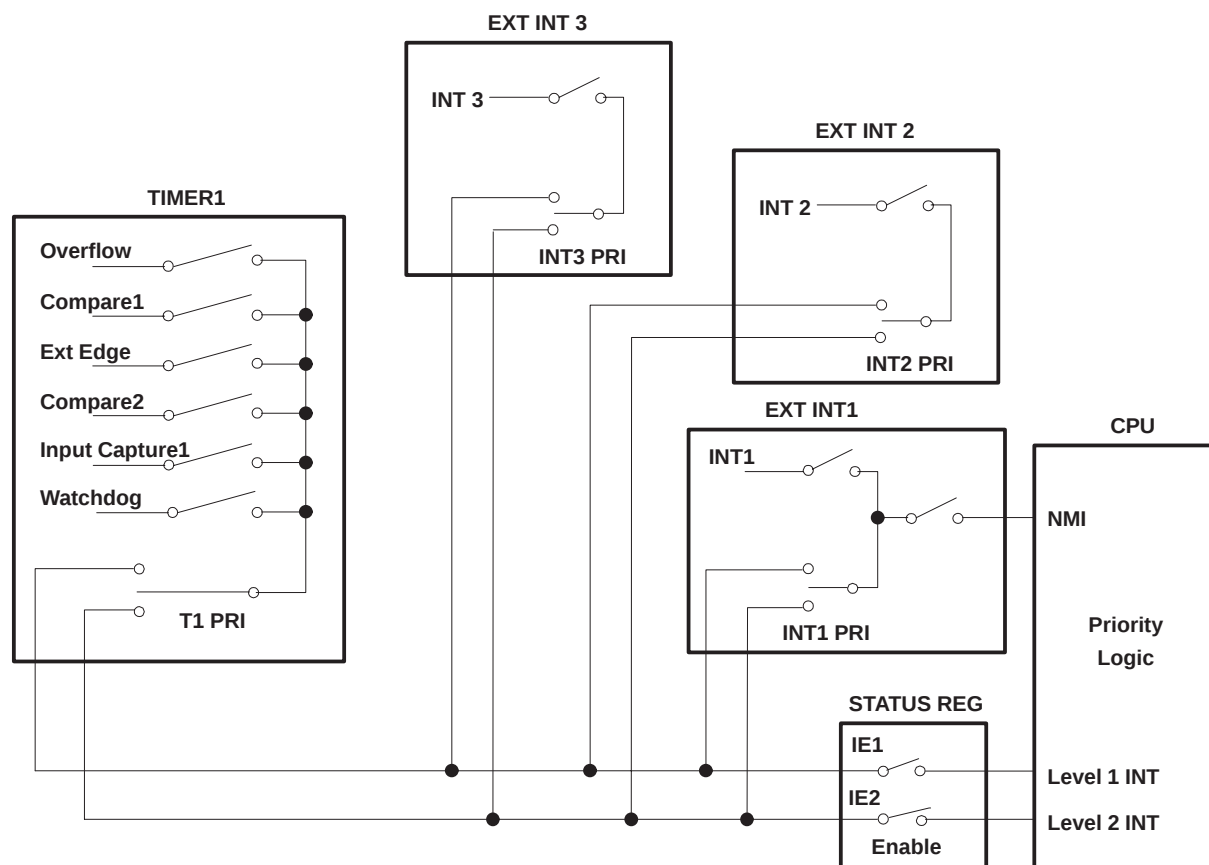


Figure 4. Interrupt Control

Each system interrupt is configured independently to either the high- or low-priority chain by the application program during system initialization. Within each interrupt chain, the interrupt priority is fixed by the position of the system interrupt. However, since each system interrupt is selectively configured on either the high- or low-priority-interrupt chain, the application program can elevate any system interrupt to the highest priority. Arbitration between the two priority levels is performed within the CPU. Arbitration within each of the priority chains is performed within the peripheral modules to support interrupt expansion for future modules. Pending interrupts are serviced upon completion of current instruction execution, depending on their interrupt mask and priority conditions.

The TMS370Cx8x has four hardware-system interrupts (plus $\overline{\text{RESET}}$) as shown in Table 8. Each system interrupt has a dedicated vector located in program memory through which control is passed to the interrupt service routines. A system interrupt may have multiple interrupt sources. All of the interrupt sources are individually maskable by local interrupt-enable control bits in the associated peripheral file. Each interrupt source FLAG bit is individually readable for software polling or to determine which interrupt source generated the associated system interrupt.

interrupts (continued)

One of the system interrupts is generated by on-chip peripheral functions, and three external interrupts are supported. Software configuration of the external interrupts is performed through the INT1, INT2, and INT3 control registers in peripheral file frame 1. Each external interrupt is individually software configurable for input polarity (rising or falling edge) for ease of system interface. External interrupt INT1 is software configurable as either a maskable or non-maskable interrupt. When INT1 is configured as non-maskable, it cannot be masked by the individual or global enable mask bits. The INT1 NMI bit is protected during non-privileged operation. It, therefore, should be configured during the initialization sequence following reset. To maximize pin flexibility, external interrupts INT2 and INT3 can be software-configured as general-purpose input/output pins if the interrupt function is not required (INT1 can be similarly configured as an input pin).

Table 8. Hardware System Interrupts

INTERRUPT SOURCE	INTERRUPT FLAG	SYSTEM INTERRUPT	VECTOR ADDRESS	PRIORITY [†]
External $\overline{\text{RESET}}$ Watchdog Overflow Oscillator Fault Detect	COLD START WD OVRFL INT FLAG OSC FLT FLAG	$\overline{\text{RESET}}$ [‡]	7FFEh, 7FFFh	1
External INT1	INT1 FLAG	INT1 [‡]	7FFCh, 7FFDh	2
External INT2	INT2 FLAG	INT2 [‡]	7FFAh, 7FFBh	3
External INT3	INT3 FLAG	INT3 [‡]	7FF8h, 7FF9h	4
Timer 1 Overflow Timer 1 Compare 1 Timer 1 Compare 2 Timer 1 External Edge Timer 1 Input Capture 1 Watchdog Overflow	T1 OVRFL INT FLAG T1C1 INT FLAG T1C2 INT FLAG T1EDGE INT FLAG T1IC1 INT FLAG WD OVRFL INT FLAG	T1INT [§]	7FF4h, 7FF5h	5

[†] Relative priority within an interrupt level

[‡] Release microcontroller from STANDBY and HALT low-power modes

[§] Release microcontroller from STANDBY low-power mode

privileged operation and EEPROM write-protection override

The TMS370Cx8x family is designed with significant flexibility to enable the designer to software-configure the system and peripherals to meet the requirements of a variety of applications. The nonprivileged mode of operation ensures the integrity of the system configuration once it is defined for an application. Following a hardware reset, the TMS370Cx8x operates in the privileged mode, where all peripheral file registers have unrestricted read/write access, and the application program configures the system during the initialization sequence following reset. As the last step of system initialization, the PRIVILEGE DISABLE bit (SCCR2.0) is set to 1 to enter the nonprivileged mode, thus disabling write operations to specific configuration-control bits within the PF. Table 9 displays the system-configuration bits, which are write-protected during the nonprivileged mode and must be configured by software prior to exiting the privileged mode.

privileged operation and EEPROM write-protection override (continued)

Table 9. Privilege Bits

REGISTER [†]		CONTROL BIT
NAME	LOCATION	
SCCRO	P010.5 P010.6	PF AUTO WAIT OSC POWER
SCCR1	P011.2 P011.4	MEMORY DISABLE AUTOWAIT DISABLE
SCCR2	P012.0 P012.1 P012.3 P012.4 P012.6 P012.7	PRIVILEGE DISABLE INT1 NMI CPU STEST BUS STEST PWRDWN/IDLE HALT/STANDBY
T1PRI	P04F.6 P04F.7	T1 PRIORITY T1 STEST

[†] The privilege bits are shown in a bold typeface in the peripheral file frame 1 section.

The WPO mode provides an external hardware method of overriding the write-protection registers (WPRs) of data EEPROM on the TMS370C080. WPO mode is entered by applying a 12-V input to the MC pin after the RESET pin input goes high (logic 1). The high voltage on the MC pin during the WPO mode is not the programming voltage for the data EEPROM or program EPROM. All EEPROM programming voltages are generated on-chip. The WPO mode provides hardware-system-level capability to modify the content of the data EEPROM while the device remains in the application but only while requiring a 12-V external input on the MC pin (normally not available in the end application except in a service or diagnostic environment).

low-power and IDLE modes

The TMS370Cx8x devices have two low-power modes (STANDBY and HALT) and an IDLE mode. For mask-ROM devices, low-power modes can be disabled permanently through a programmable contact at the time when the mask is manufactured.

The STANDBY and HALT low-power modes significantly reduce power consumption by reducing or stopping the activity of the various on-chip peripherals when processing is not required. Each of the low-power modes is entered by executing the IDLE instruction when the PWRDWN/IDLE bit in SCCR2 has been set to 1. The HALT/STANDBY bit in SCCR2 controls the low-power mode selection.

In the STANDBY mode (HALT/STANDBY = 0), all CPU activity and most peripheral module activity is stopped; however, the oscillator, internal clocks, and Timer 1 remain active. System processing is suspended until a qualified interrupt (hardware RESET, external interrupt on INT1, INT2, INT3, or timer 1 interrupt) is detected.

In the HALT mode (HALT/STANDBY = 1), the TMS370Cx8x is placed in its lowest power-consumption mode. The oscillator and internal clocks are stopped, causing all internal activity to be halted. System activity is suspended until a qualified interrupt (hardware RESET, external interrupt on the INT1, INT2, or INT3) is detected. The power-down mode-selection bits are summarized in Table 10.

low-power and IDLE modes (continued)

Table 10. Low-Power/Idle Control Bits

POWER-DOWN CONTROL BITS		MODE SELECTED
PWRDWN/IDLE (SCCR2.6)	HALT/STANDBY (SCCR2.7)	
1	0	STANDBY
1	1	HALT
0	X [†]	IDLE

[†] Don't care

When low-power modes are disabled through a programmable contact in the mask-ROM devices, writing to the SCCR2.6-7 bits is ignored. In addition, if an IDLE instruction is executed when low-power modes are disabled through a programmable contact, the device always enters the IDLE mode.

To provide a method for always exiting low-power modes for mask-ROM devices, INT1 is enabled automatically as a nonmaskable interrupt (NMI) during low-power modes when the hard watchdog mode is selected. This means that the NMI is generated always, regardless of the interrupt enable flags.

The following information is preserved throughout both the STANDBY and HALT modes: RAM (register file), CPU registers (SP, PC, and ST), I/O pin direction and output data, and status registers of all on-chip peripheral functions. Since all CPU instruction processing is stopped during the STANDBY and HALT modes, the clocking of the WD timer is inhibited.

clock modules

The 'x8x family provides two clock options that are referred to as divide-by-1 (phase-locked loop) and divide-by-4 (standard oscillator). Both the divide-by-1 and divide-by-4 options are configurable during the manufacturing process of a TMS370 microcontroller. The 'x8x masked ROM devices offer both options to meet system engineering requirements. Only one of the two clock options is allowed on each ROM device. The '686A EPROM has only the divide-by-4.

The divide-by-1 clock module option provides the capability for reduced electromagnetic interference (EMI) with no added cost.

The divide-by-1 provides a one-to-one match of the external resonator frequency (CLKIN) to the internal system clock (SYSCLK) frequency, whereas the divide-by-4 option produces a SYSCLK which is one-fourth of the frequency of the external resonator. Inside of the divide-by-1 module, the frequency of the external resonator is multiplied by four, and the clock module then divides the resulting signal by four to provide the four-phased internal system clock signals. The resulting SYSCLK is equal to the resonator frequency. These are formulated as follows:

$$\text{Divide-by-4 option : SYSCLK} = \frac{\text{external resonator frequency}}{4} = \frac{\text{CLKIN}}{4}$$

$$\text{Divide-by-1 option : SYSCLK} = \frac{\text{external resonator frequency} \times 4}{4} = \text{CLKIN}$$

The main advantage of choosing a divide-by-1 oscillator is the improved EMI performance. The harmonics of low-speed resonators extend through fewer of the emissions spectrum than the harmonics of faster resonators. The divide-by-1 provides the capability of reducing the resonator speed by four times, and this results in a steeper decay of emissions produced by the oscillator.

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system configuration registers

Table 11 contains system-configuration, control functions, and registers for controlling EEPROM programming. The privileged bits are shown in bold typeface in shaded areas.

Table 11. Peripheral File Frame 1: System-Configuration Registers

PF	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0	REG
P010	COLD START	OSC POWER	PF AUTO WAIT	OSC FLT FLAG	MC PIN WPO	MC PIN DATA	—	μP/μC MODE	SCCR0
P011	—	—	—	AUTO WAIT DISABLE	—	MEMORY DISABLE	—	—	SCCR1
P012	HALT / STANDBY	PWRDWN / IDLE	—	BUS STEST	CPU STEST	—	INT1 NMI	PRIVILEGE DISABLE	SCCR2
P013 to P016	Reserved								
P017	INT1 FLAG	INT1 PIN DATA	—	—	—	INT1 POLARITY	INT1 PRIORITY	INT1 ENABLE	INT1
P018	INT2 FLAG	INT2 PIN DATA	—	INT2 DATA DIR	INT2 DATA OUT	INT2 POLARITY	INT2 PRIORITY	INT2 ENABLE	INT2
P019	INT3 FLAG	INT3 PIN DATA	—	INT3 DATA DIR	INT3 DATA OUT	INT3 POLARITY	INT3 PRIORITY	INT3 ENABLE	INT3
P01A	BUSY	—	—	—	—	AP	W1W0	EXE	DEECTL
P01B	Reserved								
P01C	BUSY	VPPS	—	—	—	—	W0	EXE	EPCTL
P01D P01E P01F	Reserved								

digital port-control registers

Peripheral file frame 2 contains the digital I/O pin configuration and control registers. Table 12 shows the specific addresses, registers, and control bits within this peripheral file frame. Table 13 shows the port-configuration register setup.

Table 12. Peripheral File Frame 2: Digital Port-Control Registers

PF	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0	
P020	Reserved								APOINT1
P021	Port A Control Register 2 (must be 0)								APOINT2
P022	Port A Data								ADATA
P023	Port A Direction								ADIR
P024	Reserved								BPOINT1
P025	Port B Control Register 2 (must be 0)								BPOINT2
P026	Port B Data								BDATA
P027	Port B Direction								BDIR
P028	Reserved								CPOINT1
P029	Port C Control Register 2 (must be 0)								CPOINT2
P02A	Port C Data								CDATA
P02B	Port C Direction								CDIR
P02C	Port D Control Register 1 (must be 0)					—	—	—	DPOINT1
P02D	Port D Control Register 2 (must be 0) [†]					—	—	—	DPOINT2
P02E	Port D Data					—	—	—	DDATA
P02F	Port D Direction					—	—	—	DDIR

[†] To configure pin D3 as SYSCLK, set port D control register 2 = 08h.

Table 13. Port-Configuration Register Setup

PORT	PIN	abcd 00q1	abcd 00y0
A	0 – 7	Data Out q	Data In y
B	0 – 7	Data Out q	Data In y
C	0 – 7	Data Out q	Data In y
D	3 – 7	Data Out q	Data In y
a = Port x Control Register 1 b = Port x Control Register 2 c = Data d = Direction			

programmable timer 1

The programmable Timer 1 (T1) module of the TMS370Cx8x provides the designer with the enhanced timer resources required to perform real-time system control. The T1 module contains the general-purpose timer and the watchdog (WD) timer. The two independent 16-bit timers, T1 and WD timer, allow program selection of input clock sources (real-time, external event, or pulse accumulate) with multiple 16-bit registers (input capture and compare) for special timer function control. The Timer 1 module includes three external device pins that can be used for multiple counter functions (operation-mode dependent), or used as general-purpose I/O pins. The T1 module block diagram is shown in Figure 5.

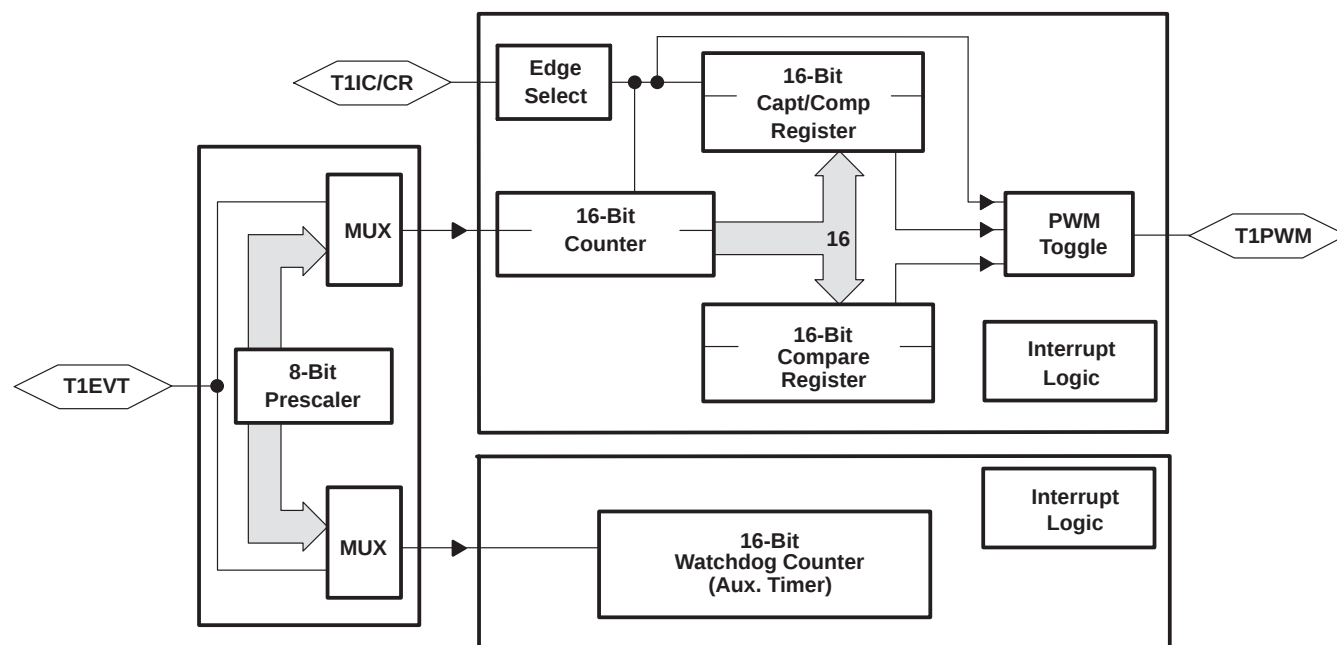


Figure 5. Timer 1 Block Diagram

- Three Timer1 I/O pins
 - T1IC/CR: T1 input capture / counter-reset input pin, or general-purpose bidirectional I/O pin
 - T1PWM: T1 pulse-width-modulation (PWM) output pin, or general-purpose bidirectional I/O pin
 - T1EVT: T1 event input pin, or general-purpose bidirectional I/O pin
- Two operational modes:
 - Dual-compare mode: Provides PWM signal
 - Capture/compare mode: Provides input capture pin
- One 16-bit general-purpose resettable counter
- One 16-bit compare register with associated compare logic
- One 16-bit capture/compare register, which, depending on the mode of operation, operates as either capture or compare registers.
- One 16-bit WD counter can be used as an event counter, a pulse accumulator, or an interval timer if WD feature is not needed.
- Prescaler/clock sources that determines one of eight clock sources for general-purpose timer

programmable timer 1 (continued)

- Selectable edge-detection circuitry that, depending on the mode of operation, senses active transitions on the input capture pins (T1IC/CR)
- Interrupts that can be generated on the occurrence of:
 - A capture
 - A compare equal
 - A counter overflow
 - An external-edge detection
- Sixteen T1 module control registers located in the PF frame beginning at address P040

The T1 module control registers are illustrated in Table 14.

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programmable timer 1 (continued)

Table 14. Timer 1 Module Register Memory Map

PF	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0	REG
Mode: Dual-Compare and Capture/Compare									
P040	T1Counter MSbyte							Bit 8	T1CNTR
P041	T1 Counter LSbyte							Bit 0	
P042	Compare Register MSbyte							Bit 8	T1C
P043	Compare Register LSbyte							Bit 0	
P044	Capture/Compare Register MSbyte							Bit 8	T1CC
P045	Capture/Compare Register LSbyte							Bit 0	
P046	Watchdog Counter MSbyte							Bit 8	WDCNTR
P047	Watchdog Counter LSbyte							Bit 0	
P048	Watchdog Reset Key							Bit 0	WDRST
P049	WD OVRFL TAP SEL†	WD INPUT SELECT2†	WD INPUT SELECT1†	WD INPUT SELECT0†	—	T1 INPUT SELECT2	T1 INPUT SELECT1	T1 INPUT SELECT0	T1CTL1
P04A	WD OVRFL RST ENA†	WD OVRFL INT ENA	WD OVRFL INT FLAG	T1 OVRFL INT ENA	T1 OVRFL INT FLAG	—	—	T1 SW RESET	T1CTL2
Mode: Dual-Compare									
P04B	T1EDGE INT FLAG	T1C2 INT FLAG	T1C1 INT FLAG	—	—	T1EDGE INT ENA	T1C2 INT ENA	T1C1 INT ENA	T1CTL3
P04C	T1 MODE=0	T1C1 OUT ENA	T1C2 OUT ENA	T1C1 RST ENA	T1CR OUT ENA	T1EDGE POLARITY	T1CR RST ENA	T1EDGE DET ENA	T1CTL4
Mode: Capture/Compare									
P04B	T1EDGE INT FLAG	—	T1C1 INT FLAG	—	—	T1EDGE INT ENA	—	T1C1 INT ENA	T1CTL3
P04C	T1 MODE = 1	T1C1 OUT ENA	—	T1C1 RST ENA	—	T1EDGE POLARITY	—	T1EDGE DET ENA	T1CTL4
Mode: Dual-Compare and Capture/Compare									
P04D	—	—	—	—	T1EVT DATA IN	T1EVT DATA OUT	T1EVT FUNCTION	T1EVT DATA DIR	T1PC1
P04E	T1PWM DATA IN	T1PWM DATA OUT	T1PWM FUNCTION	T1PWM DATA DIR	T1IC/CR DATA IN	T1IC/CR DATA OUT	T1IC/CR FUNCTION	T1IC/CR DATA DIR	T1PC2
P04F	T1 STEST	T1 PRIORITY	—	—	—	—	—	—	T1PRI

† Once the WD OVRFL RST ENA bit is set, these bits cannot be changed until a reset; this applies only to the standard watchdog and to simple counter. In the hard watchdog, these bits can be modified at any time; the WD INPUT SELECT2 bits are ignored.

programmable timer 1 (continued)

Figure 6 shows the Timer 1 capture/compare mode block diagram. The annotations on the diagram identify the register and the bit(s) in the PF. For example, the actual address of T1CTL2.0 is 104Ah, bit 0, in the T1CTL2 register.

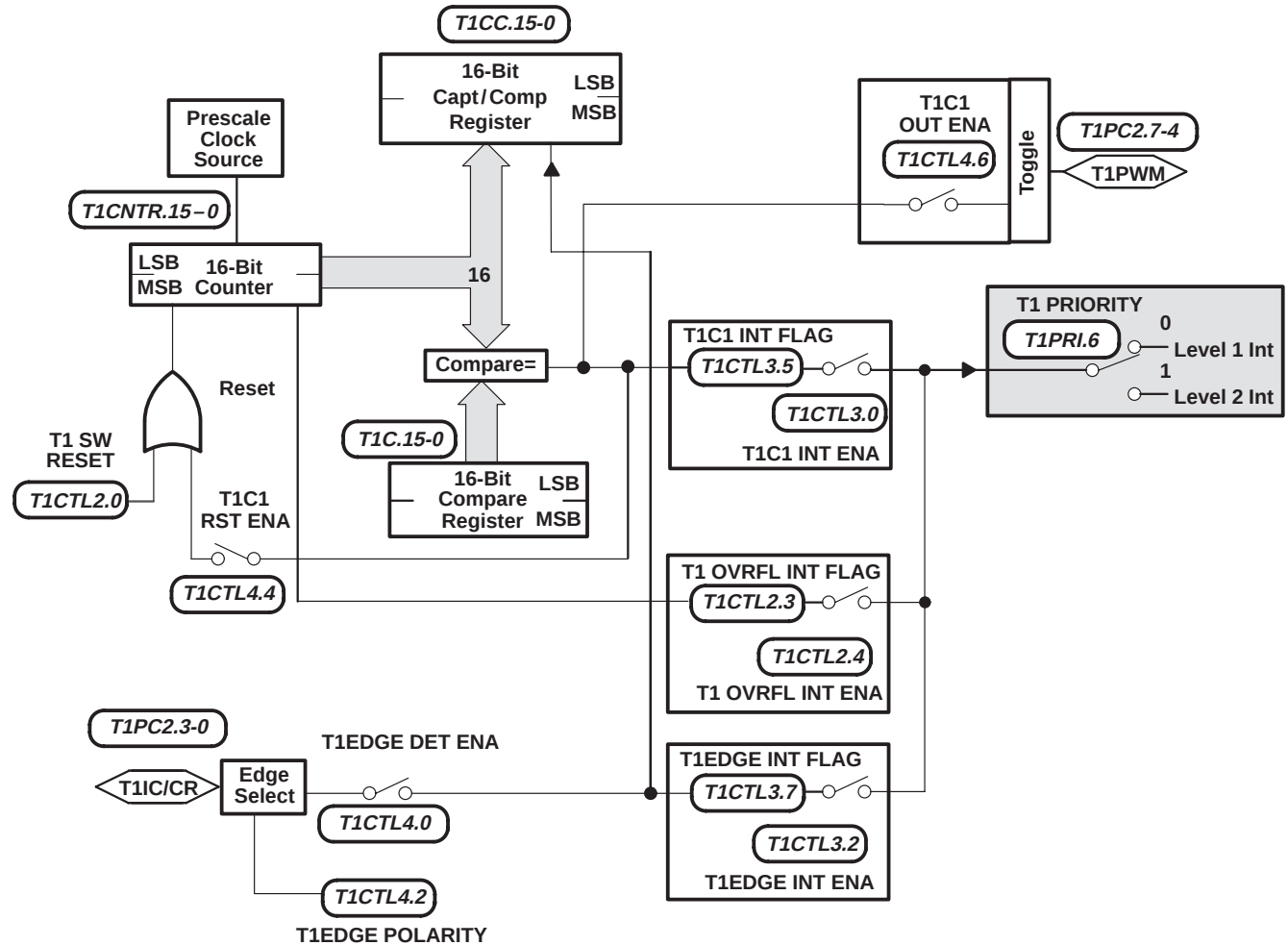


Figure 6. Capture/Compare Mode

programmable timer 1 (continued)

Figure 7 shows the Timer 1 dual-compare mode block diagram. The annotations on the diagram identify the register and the bit(s) in the peripheral frame. For example, the actual address of T1CTL2.0 is 104Ah, bit 0, in the T1CTL2 register.

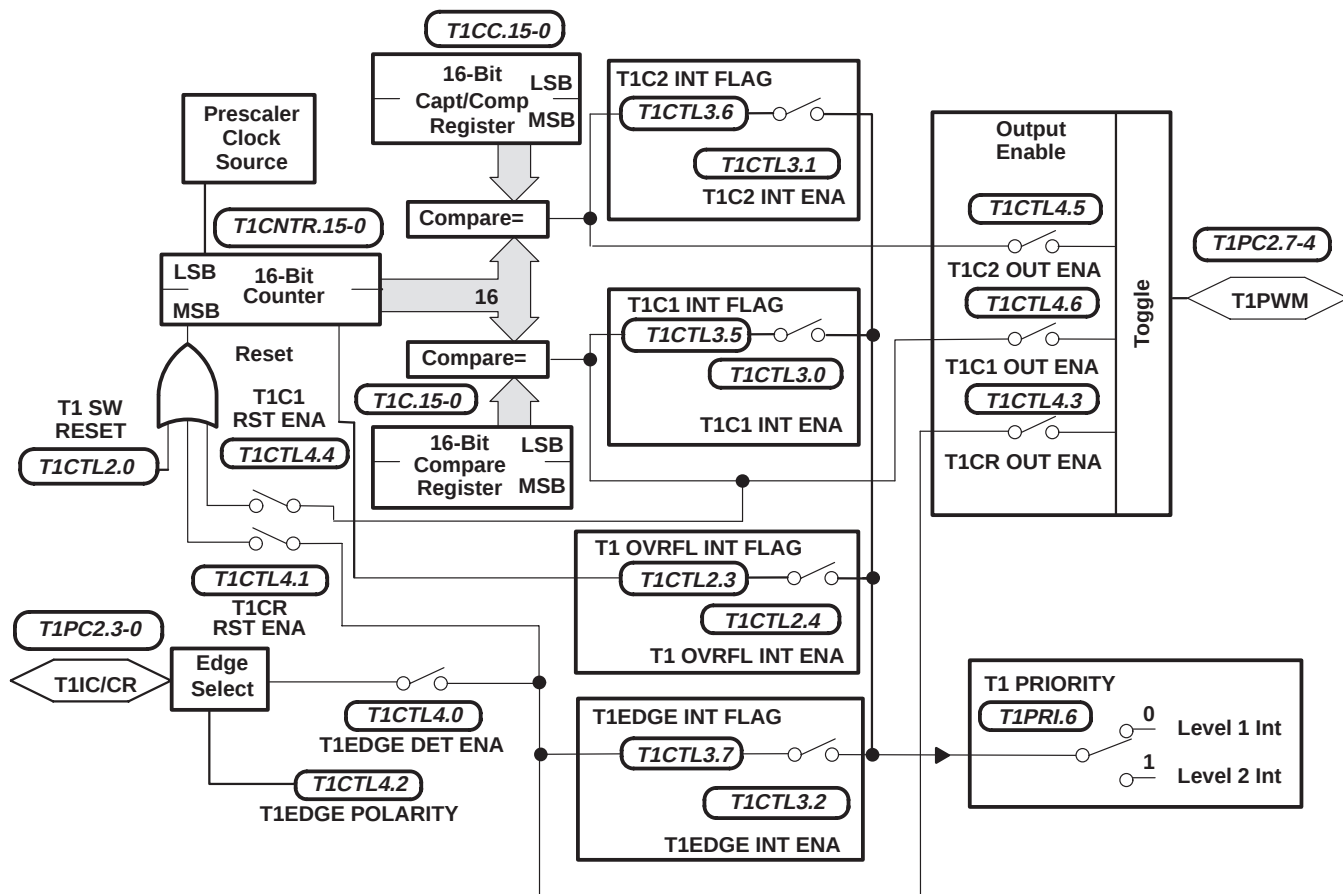


Figure 7. Dual-Compare Mode

programmable timer 1 (continued)

The TMS370Cx8x device includes a 24-bit WD timer, contained in the T1 module, which can be programmed as an event counter, pulse accumulator, or interval timer if the watchdog function is not used. The WD function is to monitor software and hardware operation and to implement a system reset when the WD counter is not properly serviced (WD counter overflow or WD counter is re-initialized by an incorrect value). The WD can be configured as one of three mask options as follows: standard watchdog, hard WD, or simple counter.

- Standard watchdog configuration (see Figure 8) for EPROM and mask-ROM devices:
 - Watchdog mode
 - Ten different WD overflow rates ranging from 6.55 ms to 3.35 s at 5-MHz SYSCCLK
 - A WD reset key (WDRST) register is used to clear the watchdog counter (WDCNTR) when a correct value is written.
 - Generates a system reset if an incorrect value is written to the watchdog reset key or if the counter overflows
 - A watchdog overflow flag (WD OVRFL INT FLAG) bit that indicates whether the WD timer initiated a system reset
 - Non-watchdog mode
 - Watchdog timer can be configured as an event counter, pulse accumulator or an interval timer

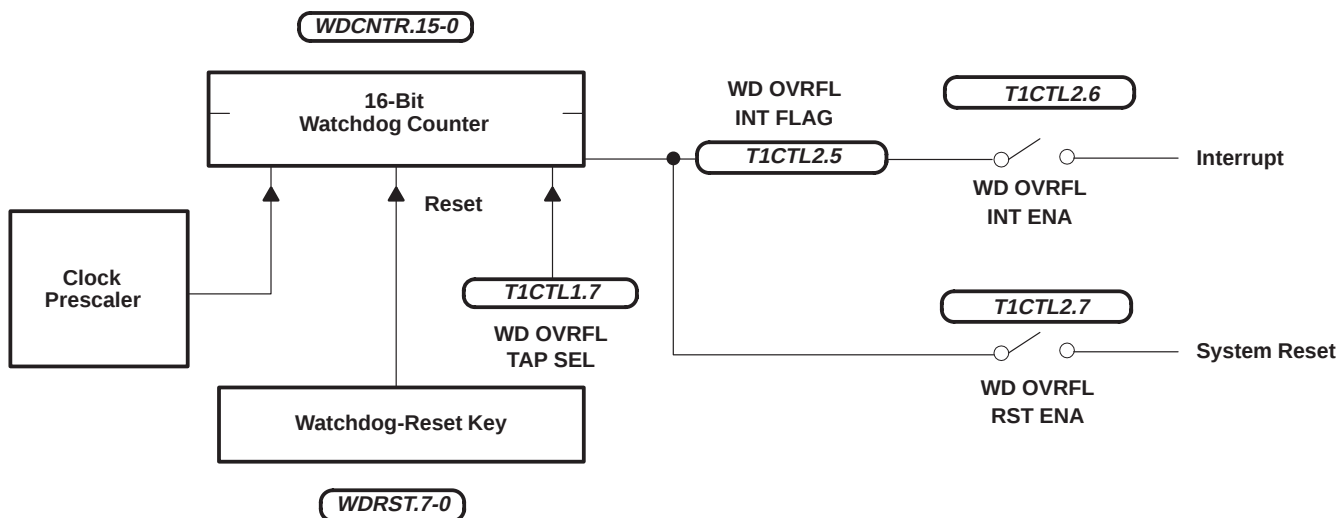


Figure 8. Standard Watchdog

programmable timer 1 (continued)

- Hard watchdog configuration (see Figure 9) for mask-ROM devices:
 - Eight different WD overflow rates ranging from 26.2 ms to 3.35 s at 5-MHz SYSCCLK
 - A WD reset key (WDRST) register is used to clear the watchdog counter (WDCNTR) when a correct value is written.
 - Generates a system reset if an incorrect value is written to the WDRST or if the counter overflows.
 - A WD overflow flag (WD OVRFL INT FLAG) bit that indicates whether the WD timer initiated a system reset.
 - Automatic activation of the WD timer upon power-up reset
 - INT1 is enabled as a nonmaskable interrupt during low-power modes.

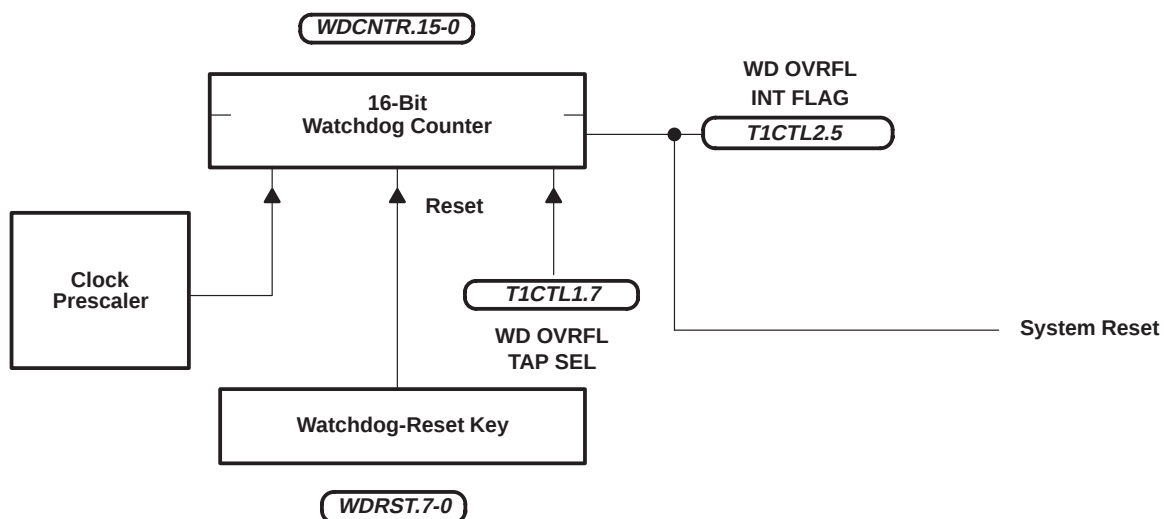


Figure 9. Hard Watchdog

programmable timer 1 (continued)

- Simple counter configuration (see Figure 10) for mask-ROM devices only
 - Simple counter can be configured as an event counter, pulse accumulator or an internal timer.

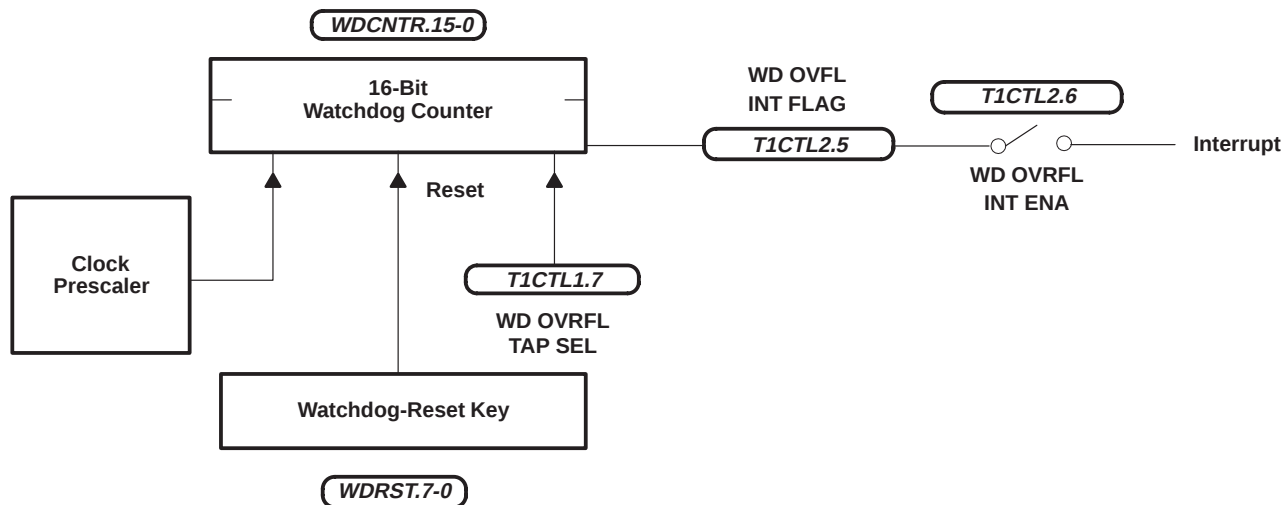


Figure 10. Simple Counter

instruction set overview

Table 15 provides an opcode-to-instruction cross reference of all 73 instructions and 274 opcodes of the '370Cx8x instruction set. The numbers at the top of this table represent the most significant nibble (MSN) of the opcode while the numbers at the left side of the table represent the least significant nibble (LSN). The instruction of these two opcode nibbles contains the mnemonic, operands, and byte/cycle particular to that opcode.

For example, the opcode B5h points to the CLR A instruction. This instruction contains one byte and executes in eight SYSCLK cycles.

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Table 15. TMS370 Family Opcode/Instruction Map†

				MSN															
				0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
L S N	0	JMP #ra 2/7							INCW #ra,Rd 3/11	MOV Ps,A 2/8					CLRC / TST A 1/9	MOV A,B 1/9	MOV A,Rd 2/7	TRAP 15 1/14	LDST n 2/6
	1	JN ra 2/5		MOV A,Pd 2/8				MOV B,Pd 2/8		MOV Rs,Pd 3/10		MOV Ps,B 2/7					MOV B,Rd 2/7	TRAP 14 1/14	MOV #ra[SP],A 2/7
	2	JZ ra 2/5	MOV Rs,A 2/7	MOV #n,A 2/6	MOV Rs,B 2/7	MOV Rs,Rd 3/9	MOV #n,B 2/6	MOV B,A 1/8	MOV #n,Rd 3/8				MOV Ps,Rd 3/10	DEC A 1/8	DEC B 1/8	DEC Rd 2/6	TRAP 13 1/14	MOV A,*ra[SP] 2/7	
	3	JC ra 2/5	AND Rs,A 2/7	AND #n,A 2/6	AND Rs,B 2/7	AND Rs,Rd 3/9	AND #n,B 2/6	AND B,A 1/8	AND #n,Rd 3/8	AND A,Pd 2/9	AND B,Pd 2/9	AND #n,Pd 3/10	INC A 1/8	INC B 1/8	INC Rd 2/6	TRAP 12 1/14	CMP *n[SP],A 2/8		
	4	JP ra 2/5	OR Rs,A 2/7	OR #n,A 2/6	OR Rs,B 2/7	OR Rs,Rd 3/9	OR #n,B 2/6	OR B,A 1/8	OR #n,Rd 3/8	OR A,Pd 2/9	OR B,Pd 2/9	OR #n,Pd 3/10	INV A 1/8	INV B 1/8	INV Rd 2/6	TRAP 11 1/14	extend inst,2 opcodes		
	5	JPZ ra 2/5	XOR Rs,A 2/7	XOR #n,A 2/6	XOR Rs,B 2/7	XOR Rs,Rd 3/9	XOR #n,B 2/6	XOR B,A 1/8	XOR #n,Rd 3/8	XOR A,Pd 2/9	XOR B,Pd 2/9	XOR #n,Pd 3/10	CLR A 1/8	CLR B 1/8	CLR Rn 2/6	TRAP 10 1/14			
	6	JNZ ra 2/5	BTJO Rs,A,ra 3/9	BTJO #n,A,ra 3/8	BTJO Rs,B,ra 3/9	BTJO Rs,Rd,ra 4/11	BTJO #n,B,ra 3/8	BTJO B,A,ra 2/10	BTJO #n,Rd,ra 4/10	BTJO A,Pd,ra 3/11	BTJO B,Pd,ra 3/10	BTJO #n,Pd,ra 4/11	XCHB A 1/10	XCHB A / TST B 1/10	XCHB Rn 2/8	TRAP 9 1/14	IDLE 1/6		
	7	JNC ra 2/5	BTJZ Rs,A,ra 3/9	BTJZ #n,A,ra 3/8	BTJZ Rs,B,ra 3/9	BTJZ Rs,Rd,ra 4/11	BTJZ #n,B,ra 3/8	BTJZ B,A,ra 2/10	BTJZ #n,Rd,ra 4/10	BTJZ A,Pd,ra 3/10	BTJZ B,Pd,ra 3/10	BTJZ #n,Pd,ra 4/11	SWAP A 1/11	SWAP B 1/11	SWAP Rn 2/9	TRAP 8 1/14	MOV #n,Pd 3/10		
	8	JV ra 2/5	ADD Rs,A 2/7	ADD #n,A 2/6	ADD Rs,B 2/7	ADD Rs,Rd 3/9	ADD #n,B 2/6	ADD B,A 1/8	ADD #n,Rd 3/8	MOVW #16,Rd 4/13	MOVW Rs,Rd 3/12	MOVW #16[B],Rpd 4/15	PUSH A 1/9	PUSH B 1/9	PUSH Rd 2/7	TRAP 7 1/14	SETC 1/7		
	9	JL ra 2/5	ADC Rs,A 2/7	ADC #n,A 2/6	ADC Rs,B 2/7	ADC Rs,Rd 3/9	ADC #n,B 2/6	ADC B,A 1/8	ADC #n,Rd 3/8	JMPL lab 3/9	JMPL *Rp 2/8	JMPL *lab[B] 3/11	POP A 1/9	POP B 1/9	POP Rd 2/7	TRAP 6 1/14	RTS 1/9		
A	JLE ra 2/5	SUB Rs,A 2/7	SUB #n,A 2/6	SUB Rs,B 2/7	SUB Rs,Rd 3/9	SUB #n,B 2/6	SUB B,A 1/8	SUB #n,Rd 3/8	MOV & lab,A 3/10	MOV *Rp,A 2/9	MOV *lab[B],A 3/12	DJNZ A,#ra 2/10	DJNZ B,#ra 2/10	DJNZ Rd,#ra 3/8	TRAP 5 1/14	RTI 1/12			
B	JHS ra 2/5	SBB Rs,A 2/7	SBB #n,A 2/6	SBB Rs,B 2/7	SBB Rs,Rd 3/9	SBB #n,B 2/6	SBB B,A 1/8	SBB #n,Rd 3/8	MOV A, & lab 3/10	MOV A, *Rp 2/9	MOV A,*lab[B] 3/12	COMPL A 1/8	COMPL B 1/8	COMPL Rd 2/6	TRAP 4 1/14	PUSH ST 1/8			

† All conditional jumps (opcodes 01-0F), BTJO, BTJZ, and DJNZ instructions use two additional cycles if the branch is taken. The BTJO, BTJZ, and DJNZ instructions have a relative address as the last operand.

Table 15. TMS370 Family Opcode/Instruction Map[†] (Continued)

		MSN															
		0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
L S N	C	JNV ra 2/5	MPY Rs,A 2/46	MPY #n,A 2/45	MPY Rs,B 2/46	MPY Rs,Rd 3/48	MPY #n,B 2/45	MPY B,A 1/47	MPY #n,Rs 3/47	BR lab 3/9	BR *Rp 2/8	BR *lab[B] 3/11	RR A 1/8	RR B 1/8	RR Rd 2/6	TRAP 3 1/14	POP ST 1/8
	D	JGE ra 2/5	CMP Rs,A 2/7	CMP #n,A 2/6	CMP Rs,B 2/7	CMP Rs,Rd 3/9	CMP #n,B 2/6	CMP B,A 1/8	CMP #n,Rd 3/8	CMP & lab,A 3/11	CMP *Rp,A 2/10	CMP *lab[B],A 3/13	RRC A 1/8	RRC B 1/8	RRC Rd 2/6	TRAP 2 1/14	LDSP 1/7
	E	JG ra 2/5	DAC Rs,A 2/9	DAC #n,A 2/8	DAC Rs,B 2/9	DAC Rs,Rd 3/11	DAC #n,B 2/8	DAC B,A 1/10	DAC #n,Rd 3/10	CALL lab 3/13	CALL *Rp 2/12	CALL *lab[B] 3/15	RL A 1/8	RL B 1/8	RL Rd 2/6	TRAP 1 1/14	STSP 1/8
	F	JLO ra 2/5	DSB Rs,A 2/9	DSB #n,A 2/8	DSB Rs,B 2/9	DSB Rs,Rd 3/11	DSB #n,B 2/8	DSB B,A 1/10	DSB #n,Rd 3/10	CALLR lab 3/15	CALLR *Rp 2/14	CALLR *lab[B] 3/17	RLC A 1/8	RLC B 1/8	RLC Rd 2/6	TRAP 0 1/14	NOP 1/7

Second byte of two-byte instructions (F4xx):

F4	8	MOVW *n[Rn] 4/15	DIV Rn,A 3/14-63
F4	9	JMPL *n[Rn] 4/16	
F4	A	MOV *n[Rn],A 4/17	
F4	B	MOV A,*n[Rn] 4/16	
F4	C	BR *n[Rn] 4/16	
F4	D	CMP *n[Rn],A 4/18	
F4	E	CALL *n[Rn] 4/20	
F4	F	CALLR *n[Rn] 4/22	

Legend:

- * = Indirect addressing operand prefix
- & = Direct addressing operand prefix
- # = immediate operand
- #16 = immediate 16-bit number
- lab = 16-label
- n = immediate 8-bit number
- Pd = Peripheral register containing destination type
- Pn = Peripheral register
- Ps = Peripheral register containing source byte
- ra = Relative address
- Rd = Register containing destination type
- Rn = Register file
- Rp = Register pair
- Rpd = Destination register pair
- Rps = Source Register pair
- Rs = Register containing source byte

[†] All conditional jumps (opcodes 01-0F), BTJO, BTJZ, and DJNZ instructions use two additional cycles if the branch is taken. The BTJO, BTJZ, and DJNZ instructions have a relative address as the last operand.

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development system support

The TMS370 family development support tools include an assembler, a C compiler, a linker, CDT and an EEPROM/UVEPROM programmer.

- Assembler/linker (Part No. TMDS3740850–02 for PC)
 - Includes extensive macro capability
 - Provides high-speed operation
 - Includes format conversion utilities for popular formats
- ANSI C Compiler (Part No. TMDS3740855–02 for PC, Part No. TMDS3740555–09 for HP700™, Sun-3™ or Sun-4™)
 - Generates assembly code for the TMS370 that can be inspected easily
 - Improves code execution speed and reduces code size with optional optimizer pass
 - Enables direct reference to the TMS370's port registers by using a naming convention
 - Provides flexibility in specifying the storage for data objects
 - Interfaces C functions and assembly functions easily
 - Includes assembler and linker
- CDT370 (Compact Development Tool) real-time in-circuit emulation
 - Base (Part Number EDSCDT370 – for PC, requires cable)
 - Cable for 40-pin DIP (Part No. EDSTRG40DIL8X)
 - Cable for 44-pin PLCC (Part No. EDSTRG44PLCC8X)
 - Provides EEPROM and EPROM programming support
 - Allows inspection and modification of memory locations
 - Includes compatibility to upload/download program and data memory
 - Executes programs and software routines
 - Includes 1024-sample trace buffer
 - Includes single-step executable instructions
 - Uses software breakpoints to halt program execution at selected address
 - Provides timers for analyzing total and average time in routines
 - Contains an eight-line logic probe for adding visibility of external signals to the breakpoint qualifier and to trace display
- Microcontroller programmer
 - Base (Part No. TMDS3760500A – for PC, requires programmer head)
 - Single unit head for 44-pin PLCC (Part No. TMDS3780510A)
 - Single unit head for 40-pin DIP (Part No. TMDS3780511A)
 - PC-based, window/function-key-oriented user interface for ease of use and rapid learning environment
- Converter Socket (Part No. TMDS37788OTP)

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device numbering conventions

Figure 11 illustrates the numbering and symbol nomenclature for the TMS370Cx8x family.

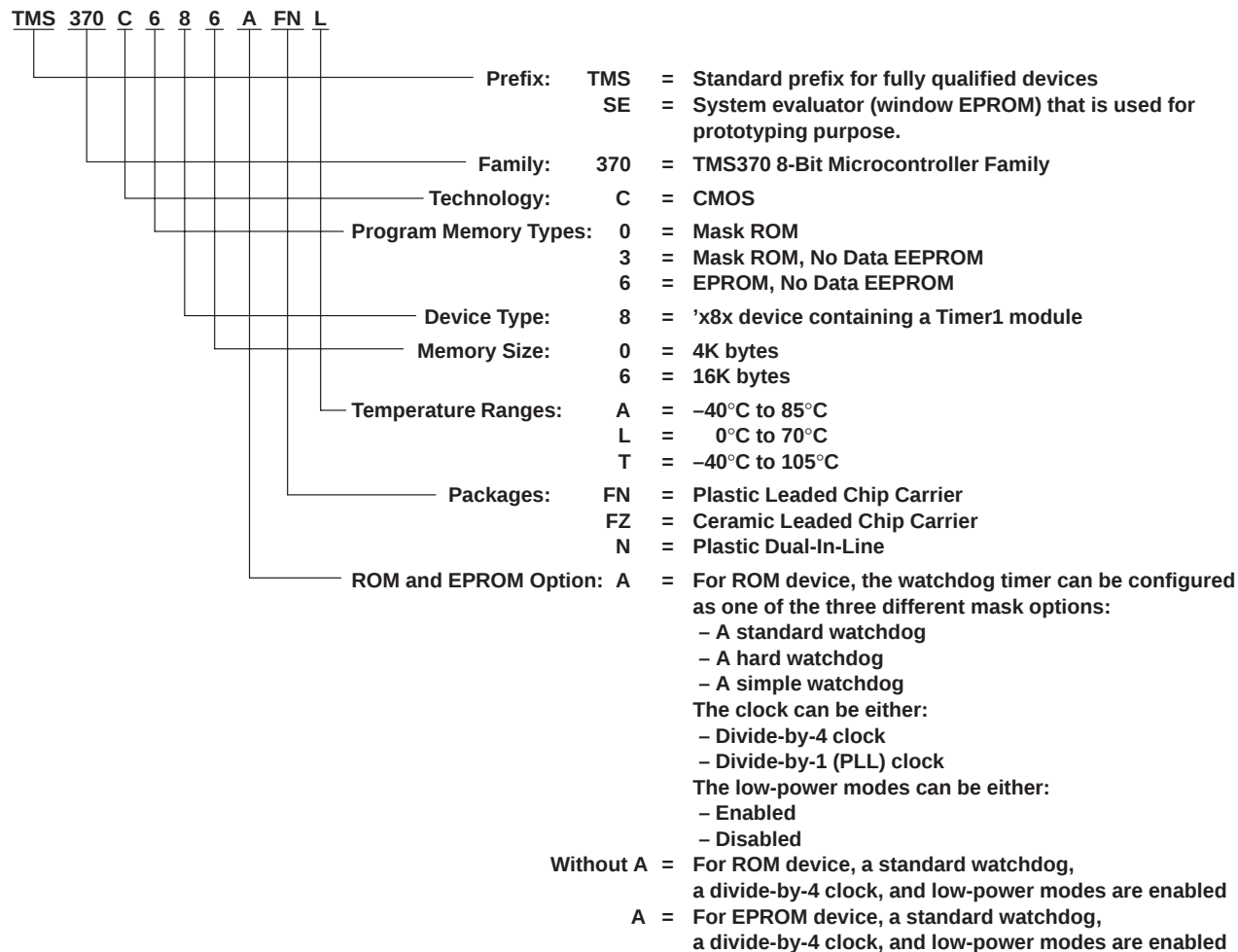


Figure 11. TMS370Cx8x Family Nomenclature

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device part numbers

Table 16 provides all of the 'x8x devices available. The device part number nomenclature is designed to assist ordering. Upon ordering, the customer must specify not only the device part number, but also the clock and watchdog timer options desired. Each device can have only one of the three possible watchdog timer options and one of the two clock options. The options to be specified pertain solely to orders involving ROM devices.

Table 16. Device Part Numbers

DEVICES PART NUMBERS FOR 44 PINS (LCC)	DEVICES PART NUMBERS FOR 40 PINS (PDIP)
TMS370C380AFNA TMS370C380AFNL TMS370C380AFNT	TMS370C080NA TMS370C080NL TMS370C080NT
TMS370C686AFNT	—
SE370C686AFZT†	—

† System evaluators are for use in prototype environment and their reliability has not been characterized.

Figure 12 shows a sample of the new code release form.

Figure 12. Sample New Code Release Form

Table 17 is a collection of all the peripheral file frames used in the 'Cx8x (provided for a quick reference).

Table 17. Peripheral File Frame Compilation

System Configuration Registers									
PF	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0	REG
P010	COLD START	OSC POWER	PF AUTO WAIT	OSC FLT FLAG	MC PIN WPO	MC PIN DATA	—	μP/μC MODE	SCCR0
P011	—	—	—	AUTO WAIT DISABLE	—	MEMORY DISABLE	—	—	SCCR1
P012	HALT / STANDBY	PWRDWN / IDLE	—	BUS STEST	CPU STEST	—	INT1 NMI	PRIVILEGE DISABLE	SCCR2
P013 to P016	Reserved								
P017	INT1 FLAG	INT1 PIN DATA	—	—	—	INT1 POLARITY	INT1 PRIORITY	INT1 ENABLE	INT1
P018	INT2 FLAG	INT2 PIN DATA	—	INT2 DATA DIR	INT2 DATA OUT	INT2 POLARITY	INT2 PRIORITY	INT2 ENABLE	INT2
P019	INT3 FLAG	INT3 PIN DATA	—	INT3 DATA DIR	INT3 DATA OUT	INT3 POLARITY	INT3 PRIORITY	INT3 ENABLE	INT3
P01A	BUSY	—	—	—	—	AP	W1W0	EXE	DEECTL
P01B	Reserved								
P01C	BUSY	VPPS	—	—	—	—	W0	EXE	EPCTL
P01D to P01F	Reserved								
Digital Port Control Registers									
P020	Reserved								APORT1
P021	Port A Control Register 2 (must be 0)								APORT2
P022	Port A Data								ADATA
P023	Port A Direction								ADIR
P024	Reserved								BPORT1
P025	Port B Control Register 2 (must be 0)								BPORT2
P026	Port B Data								BDATA
P027	Port B Direction								BDIR
P028	Reserved								CPORT1
P029	Port C Control Register 2 (must be 0)								CPORT2
P02A	Port C Data								CDATA
P02B	Port C Direction								CDIR
P02C	Port D Control Register 1 (must be 0)					—	—	—	DPORT1
P02D	Port D Control Register 2 (must be 0) [†]					—	—	—	DPORT2
P02E	Port D Data					—	—	—	DDATA
P02F	Port D Direction					—	—	—	DDIR
Timer1 Module Register Memory Map									
Modes: Dual-Compare and Capture/Compare									
P040	Bit 15	T1Counter MSbyte						Bit 8	T1CNTR
P041	Bit 7	T1 Counter LSbyte						Bit 0	

[†] To configure pin D3 as SYSCLK, set port D control register 2 = 08h.

Table 17. Peripheral File Frame Compilation (Continued)

PF	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0	REG
Modes: Dual-Compare and Capture/Compare (Continued)									
P042	Compare Register MSbyte							Bit 8	T1C
P043	Compare Register LSbyte							Bit 0	
P044	Capture/Compare Register MSbyte							Bit 8	T1CC
P045	Capture/Compare Register LSbyte							Bit 0	
P046	Watchdog Counter MSbyte							Bit 8	WDCNTR
P047	Watchdog Counter LSbyte							Bit 0	
P048	Watchdog Reset Key							Bit 0	WDRST
P049	WD OVRFL TAP SEL†	WD INPUT SELECT2†	WD INPUT SELECT1†	WD INPUT SELECT0†	—	T1 INPUT SELECT2	T1 INPUT SELECT1	T1 INPUT SELECT0	T1CTL1
P04A	WD OVRFL RST ENA†	WD OVRFL INT ENA	WD OVRFL INT FLAG	T1 OVRFL INT ENA	T1 OVRFL INT FLAG	—	—	T1 SW RESET	T1CTL2
Mode: Dual-Compare									
P04B	T1EDGE INT FLAG	T1C2 INT FLAG	T1C1 INT FLAG	—	—	T1EDGE INT ENA	T1C2 INT ENA	T1C1 INT ENA	T1CTL3
P04C	T1 MODE=0	T1C1 OUT ENA	T1C2 OUT ENA	T1C1 RST ENA	T1CR OUT ENA	T1EDGE POLARITY	T1CR RST ENA	T1EDGE DET ENA	T1CTL4
Mode: Capture / Compare									
P04B	T1EDGE INT FLAG	—	T1C1 INT FLAG	—	—	T1EDGE INT ENA	—	T1C1 INT ENA	T1CTL3
P04C	T1 MODE = 1	T1C1 OUT ENA	—	T1C1 RST ENA	—	T1EDGE POLARITY	—	T1EDGE DET ENA	T1CTL4
Modes: Dual-Compare and Capture/Compare									
P04D	—	—	—	—	T1EVT DATA IN	T1EVT DATA OUT	T1EVT FUNCTION	T1EVT DATA DIR	T1PC1
P04E	T1PWM DATA IN	T1PWM DATA OUT	T1PWM FUNCTION	T1PWM DATA DIR	T1IC/CR DATA IN	T1IC/CR DATA OUT	T1IC/CR FUNCTION	T1IC/CR DATA DIR	T1PC2
P04F	T1 STEST	T1 PRIORITY	—	—	—	—	—	—	T1PRI

† Once the WD OVRFL RST ENA bit is set, these bits cannot be changed until a reset; this applies only to the standard watchdog and to simple counter. In the hard watchdog, these bits can be modified at any time; the WD INPUT SELECT2 bits are ignored.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC} (see Note 1)	–0.6 V to 7 V
Input voltage range, All pins except MC	–0.6 V to 7 V
MC	–0.6 V to 14 V
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)	±20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	±20 mA
Continuous output current per buffer, I_O ($V_O = 0$ to V_{CC}) (see Note 2)	±10 mA
Maximum I_{CC} current	170 mA
Maximum I_{SS} current	–170 mA
Continuous power dissipation	1 W
Operating free-air temperature range, T_A : L version	0°C to 70°C
A version	–40°C to 85°C
T version	–40°C to 105°C
Storage temperature range, T_{stg}	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. Unless otherwise noted, all voltage values are with respect to V_{SS} .

2. Electrical characteristics are specified with all output buffers loaded with specified I_O current. Exceeding the specified I_O current in any buffer can affect the levels on other buffers.

recommended operating conditions

			MIN	NOM	MAX	UNIT
V_{CC}	Supply voltage (see Note 1)		4.5	5	5.5	V
	RAM data-retention supply voltage (see Note 3)		3		5.5	V
V_{IL}	Low-level input voltage	All pins except MC	V_{SS}		0.8	V
		MC, normal operation	V_{SS}		0.3	
V_{IH}	High-level input voltage	All pins except MC, XTAL2/CLKIN, and RESET	2		V_{CC}	V
		XTAL2/CLKIN	0.8 V_{CC}		V_{CC}	
		RESET	0.7 V_{CC}		V_{CC}	
V_{MC}	MC (mode control) voltage	EEPROM write protect override (WPO)	11.7	12	13	V
		EPROM programming voltage (V_{PP})	13	13.2	13.5	
		Microcomputer	V_{SS}		0.3	
T_A	Operating free-air temperature	L version	0		70	°C
		A version	–40		85	
		T version	–40		105	

NOTES: 1. Unless otherwise noted, all voltage values are with respect to V_{SS} .

3. RESET must be externally activated when V_{CC} or SYSCLK is not within the recommended operating range.



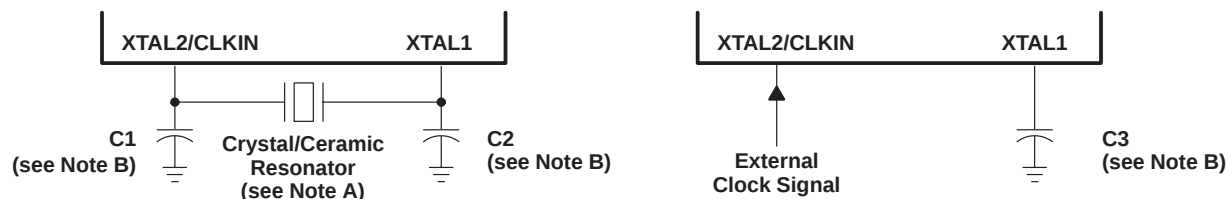
electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
V _{OL}	Low-level output voltage	I _{OL} = 1.4 mA			0.4	V
V _{OH}	High-level output voltage	I _{OH} = –50 µA	0.9 V _{CC}			V
		I _{OH} = –2 mA	2.4			
I _I	Input current	MC	0 V < V _I ≤ 0.3 V		10	µA
			0.3 V < V _I ≤ 13 V		650	
			See Note 4 12 V ≤ V _I ≤ 13 V		50	mA
		I/O pins	0 V ≤ V _I ≤ V _{CC}		± 10	µA
I _{OL}	Low-level output current	V _{OL} = 0.4 V	1.4			mA
I _{OH}	High-level output current	V _{OH} = 0.9 V _{CC}	– 50			µA
		V _{OH} = 2.4 V	– 2			mA
I _{CC}	Supply current (operating mode) OSC POWER bit = 0 (see Note 7)	See Notes 5 and 6 SYSCLK = 5 MHz		30	45	mA
		See Notes 5 and 6 SYSCLK = 3 MHz		20	30	
		See Notes 5 and 6 SYSCLK = 0.5 MHz		7	11	
	Supply current (STANDBY mode) OSC POWER bit = 0 (see Note 8)	See Notes 5 and 6 SYSCLK = 5 MHz		10	17	mA
		See Notes 5 and 6 SYSCLK = 3 MHz		8	11	
		See Notes 5 and 6 SYSCLK = 0.5 MHz		2	3.5	
	Supply current (STANDBY mode) OSC POWER bit = 1 (see Note 9)	See Notes 5 and 6 SYSCLK = 3 MHz		6	8.6	mA
		See Notes 5 and 6 SYSCLK = 0.5 MHz		2	3.0	
	Supply current (HALT mode)	See Note 5 XTAL2/CLKIN < 0.2 V		2	30	µA

- NOTES: 4. Input current I_{pp} is a maximum of 50 mA only when you are programming EPROM.
5. Single-chip mode, ports configured as inputs or outputs with no load. All inputs ≤ 0.2 V or ≥ V_{CC} – 0.2V.
6. XTAL2/CLKIN is driven with an external square wave signal with 50% duty cycle and rise and fall times less than 10 ns. Current can be higher with a crystal oscillator. At 5 MHz SYSCLK, this extra current = 0.01 mA x (total load capacitance + crystal capacitance in pF).
7. Maximum operating current = 7.6 (SYSCLK) + 7 mA.
8. Maximum standby current = 3 (SYSCLK) + 2 mA. (OSC POWER bit = 0).
9. Maximum standby current = 2.24 (SYSCLK) + 1.9 mA. (OSC POWER bit = 1, only valid up to 3 MHz SYSCLK).

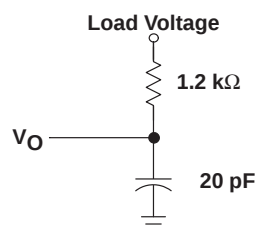
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NOTES: A. The crystal/ceramic resonator frequency is four times the reciprocal of the system clock period.
B. The values of C1 and C2 are typically 15 pF and the value of C3 is typically 50 pF. See the manufacturer's recommendations for ceramic resonators.

Figure 13. Recommended Crystal/Clock Connections



Case 1: $V_O = V_{OH} = 2.4 \text{ V}$; Load Voltage = 0 V
Case 2: $V_O = V_{OL} = 0.4 \text{ V}$; Load Voltage = 2.1 V

NOTE A: All measurements are made with the pin loading as shown unless otherwise noted. All measurements are made with XTAL2/CLKIN driven by an external square wave signal with a 50% duty cycle and rise and fall times less than 10 ns unless otherwise stated.

Figure 14. Typical Output Load Circuit (See Note A)

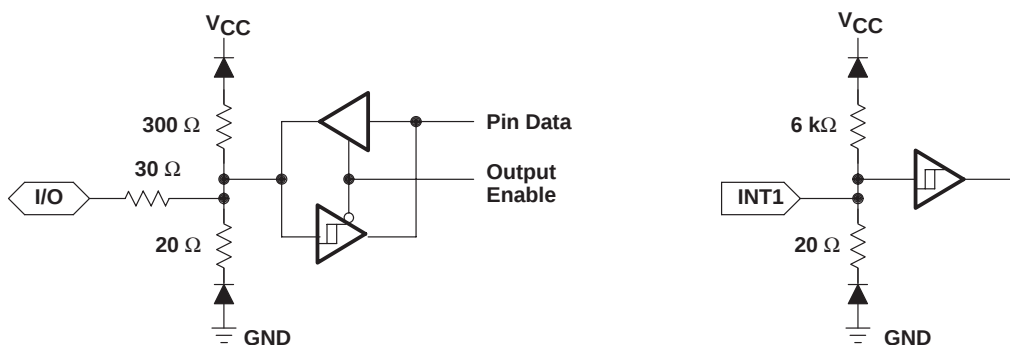


Figure 15. Typical Buffer Circuitry

PARAMETER MEASUREMENT INFORMATION

timing parameter symbology

Timing parameter symbols have been created in accordance with JEDEC Standard 100. In order to shorten the symbols, some of the pin names and other related terminology have been abbreviated as follows:

AR	Array	CI	XTAL2/CLKIN
B	Byte	SC	SYSCLK

Lowercase subscripts and their meanings are:

c	cycle time (period)	su	setup time
d	delay time	v	valid time
f	fall time	w	pulse duration (width)
r	rise time		

The following additional letters are used with these meanings:

H	High
L	Low
V	Valid

All timings are measured between high and low measurement points as indicated in Figure 16 and Figure 17.



Figure 16. XTAL2/CLKIN Measurement Points

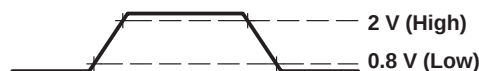


Figure 17. General Measurement Points

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external clocking requirements for clock divided by 4 (see Note 10 and Figure 18)

NO.	PARAMETER	MIN	MAX	UNIT
1	$t_w(\text{Cl})$ Pulse duration, XTAL2/CLKIN (see Note 11)	20		ns
2	$t_r(\text{Cl})$ Rise time, XTAL2/CLKIN		30	ns
3	$t_f(\text{Cl})$ Fall time, XTAL2/CLKIN		30	ns
4	$t_d(\text{ClH-SCL})$ Delay time, XTAL2/CLKIN rise to SYSCLK fall		100	ns
	CLKIN Crystal operating frequency	2	20	MHz
	SYSCLK Internal system clock operating frequency [†]	0.5	5	MHz

[†] SYSCLK = CLKIN/4

NOTES: 10. For V_{IL} and V_{IH} , refer to recommended operating conditions.

11. This pulse may be either a high pulse, which extends from the earliest valid high to the final valid high in an XTAL2/CLKIN cycle or a low pulse, which extends from the earliest valid low to the final valid low in an XTAL2/CLKIN cycle.

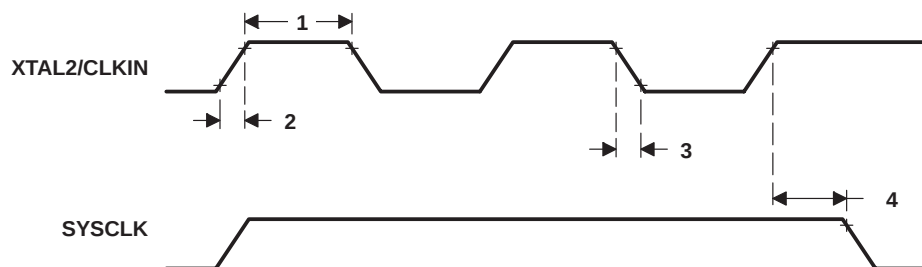


Figure 18. External Clock Timing for Divide-by-4

external clocking requirements for clock divided by 1 (PLL) (see Note 10 and Figure 19)

NO.	PARAMETER	MIN	MAX	UNIT
1	$t_w(\text{Cl})$ Pulse duration, XTAL2/CLKIN (see Note 11)	20		ns
2	$t_r(\text{Cl})$ Rise time, XTAL2/CLKIN		30	ns
3	$t_f(\text{Cl})$ Fall time, XTAL2/CLKIN		30	ns
4	$t_d(\text{ClH-SCH})$ Delay time, XTAL2/CLKIN rise to SYSCLK rise		100	ns
	CLKIN Crystal operating frequency	2	5	MHz
	SYSCLK Internal system clock operating frequency [‡]	2	5	MHz

[‡] SYSCLK = CLKIN/1

NOTES: 10. For V_{IL} and V_{IH} , refer to recommended operating conditions.

11. This pulse can be either a high pulse, which extends from the earliest valid high to the final valid high in an XTAL2/CLKIN cycle or a low pulse, which extends from the earliest valid low to the final valid low in an XTAL2/CLKIN cycle.

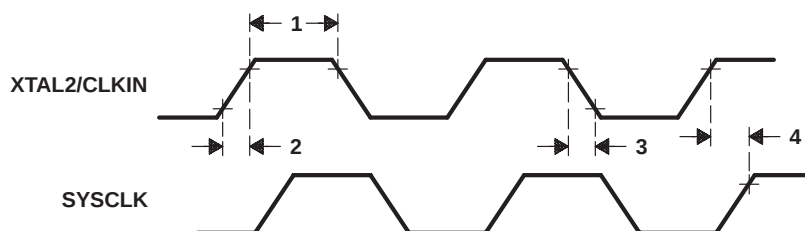


Figure 19. External Clock Timing for Divide-by-1

switching characteristics and timing requirements (see Note 12)

NO.	PARAMETER		MIN	MAX	UNIT
5	t_c	Cycle time, SYSCLK (system clock)	Divide-by-4	200	ns
			Divide-by-1	200	
6	$t_w(\text{SCL})$	Pulse duration, SYSCLK low	$0.5 t_c - 20$	$0.5 t_c$	ns
7	$t_w(\text{SCH})$	Pulse duration, SYSCLK high	$0.5 t_c$	$0.5 t_c + 20$	ns

NOTE 12: t_c = system-clock cycle time = $1/\text{SYSCLK}$

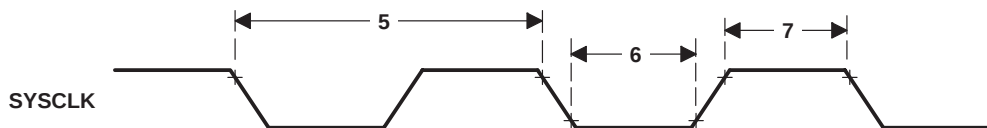


Figure 20. SYSCLK Timing

general purpose output signal switching time requirements

	MIN	NOM	MAX	UNIT
t_r Rise time		30		ns
t_f Fall time		30		ns

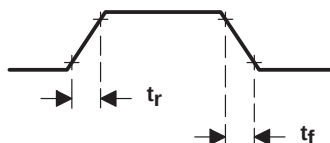


Figure 21. Signal Switching Timing

recommended EEPROM timing requirements for programming

	MIN	MAX	UNIT
$t_w(\text{PGM})\text{B}$	Pulse duration, programming signal to ensure valid data is stored (byte mode)	10	ms
$t_w(\text{PGM})\text{AR}$	Pulse duration, programming signal to ensure valid data is stored (array mode)	20	ms

recommended EPROM operating conditions for programming

			MIN	NOM	MAX	UNIT
VCC	Supply voltage		4.75	5.5	6	V
VPP	Supply voltage at MC pin		13	13.2	13.5	V
IPP	Supply current at MC pin during programming (VPP = 13 V)			30	50	mA
SYSCLK	System clock	Divide-by-4	0.5		5	MHz
		Divide-by-1	2		5	

recommended EPROM timing requirements for programming

		MIN	NOM	MAX	UNIT
t _w (EPGM)	Pulse duration, programming signal (see Note 13)	0.40	0.50	3	ms

NOTE 13: Programming pulse is active when both EXE (EPCTL.0) and VPPS (EPCTL.6) are set.

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Table 18 is designed to aid the user in referencing a device part number to a mechanical drawing. The table shows a cross-reference of the device part number to the TMS370 generic package name and the associated mechanical drawing by drawing number and name.

Table 18. TMS370Cx8x Family Package Type and Mechanical Cross-Reference

PKG TYPE (mil pin spacing)	TMS370 GENERIC NAME	PKG TYPE NO. AND MECHANICAL NAME	DEVICE PART NUMBERS
FN – 44 pin (50-mil pin spacing)	PLASTIC LEADED CHIP CARRIER (PLCC)	FN(S-PQCC-J**) PLASTIC J-LEADED CHIP CARRIER	TMS370C380AFNA TMS370C380AFNL TMS370C380AFNT TMS370C686AFNT
FZ – 44 pin (50-mil pin spacing)	CERAMIC LEADED CHIP CARRIER (CLCC)	FZ(S-CQCC-J**) J-LEADED CERAMIC CHIP CARRIER	SE370C686AFZT
N – 40 pin (100-mil pin spacing)	PLASTIC DUAL-IN-LINE PACKAGE (PDIP)	N(R-PDIP-T**) PLASTIC DUAL-IN-LINE PACKAGE	TMS370C080NA TMS370C080NL TMS370C080NT

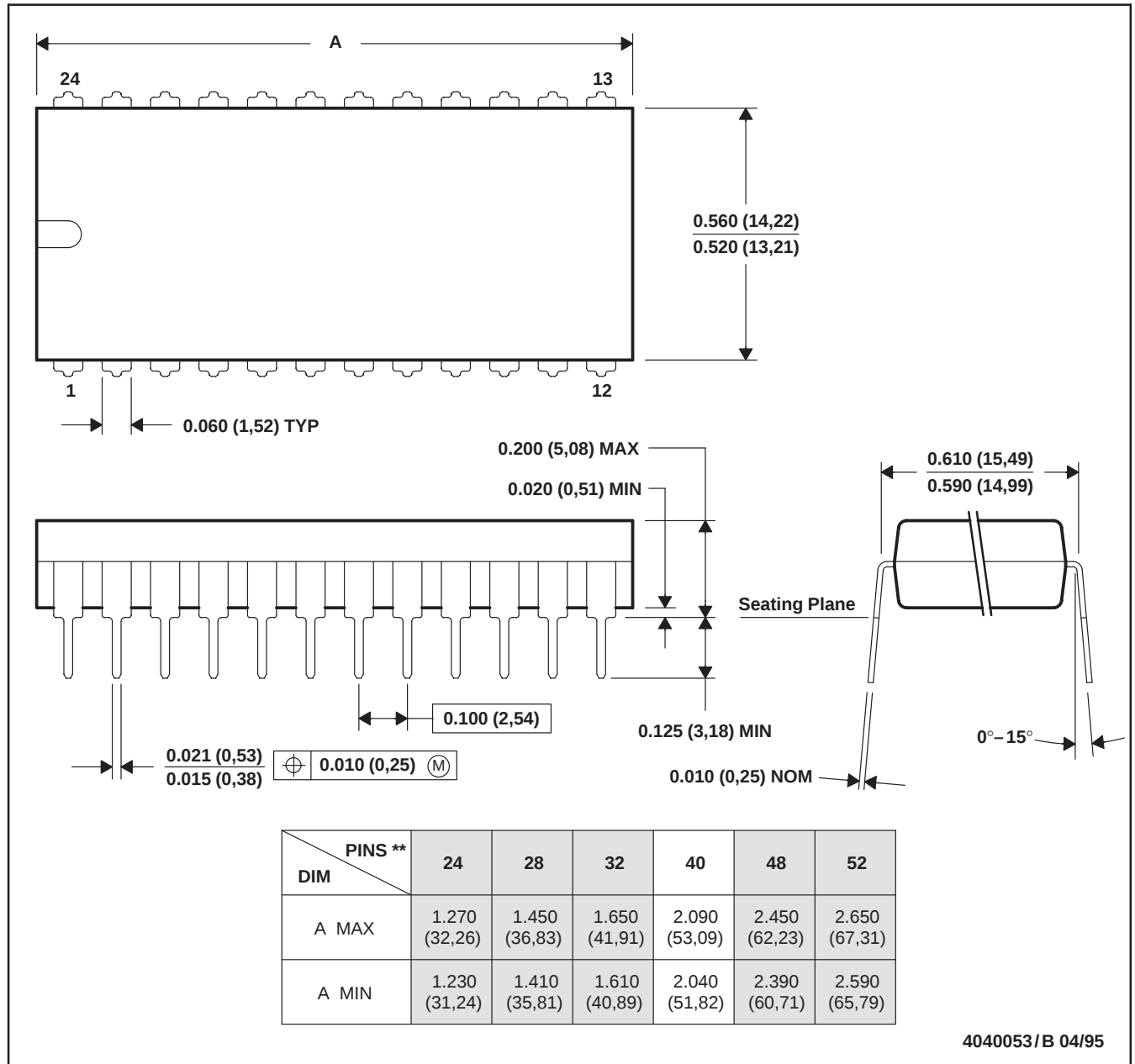


MECHANICAL DATA

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

24 PIN SHOWN



- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - Falls within JEDEC MS-011
 - Falls within JEDEC MS-015 (32 pin only)

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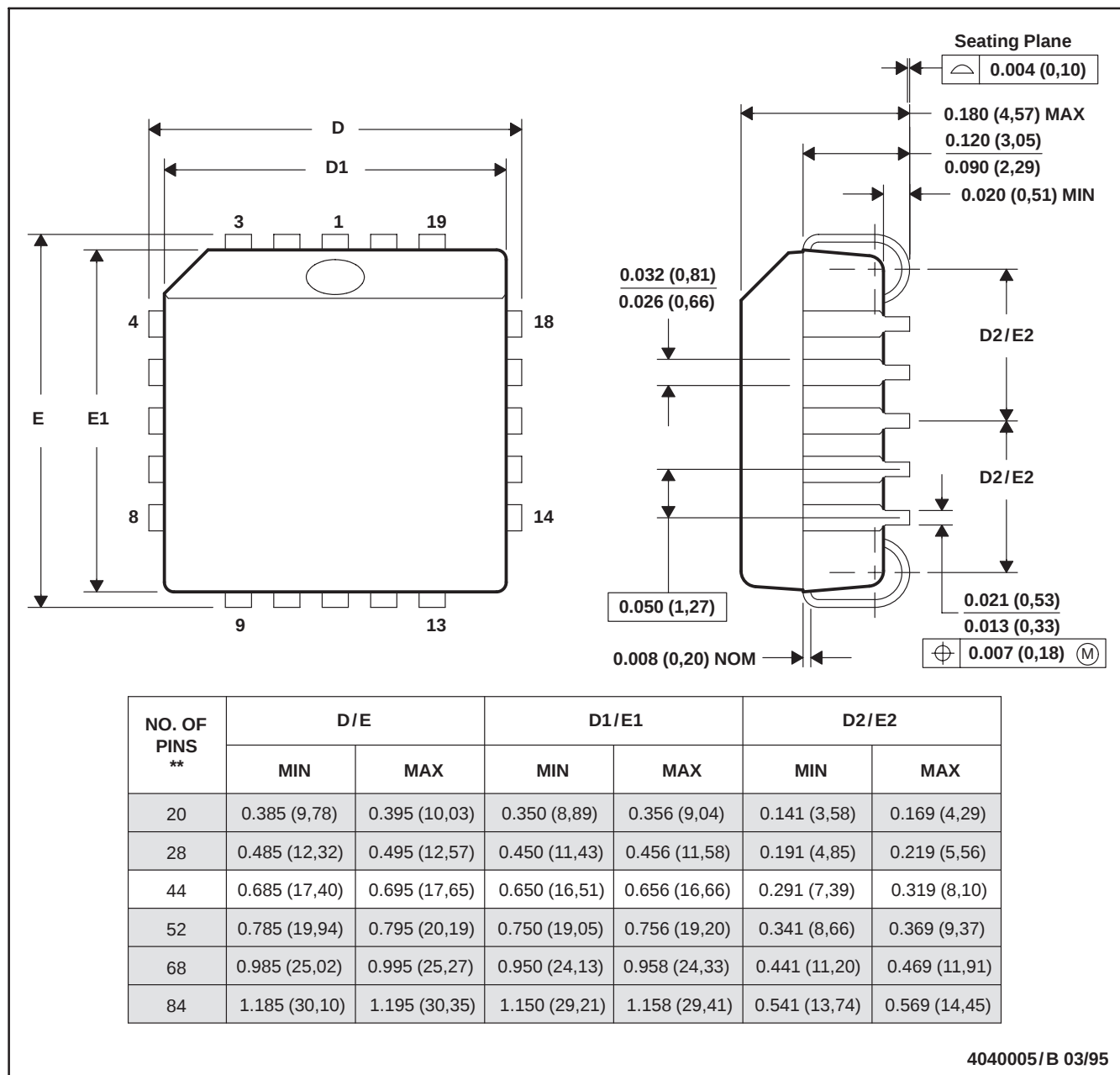
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MECHANICAL DATA

FN (S-PQCC-J**)

PLASTIC J-LEADED CHIP CARRIER

20 PIN SHOWN



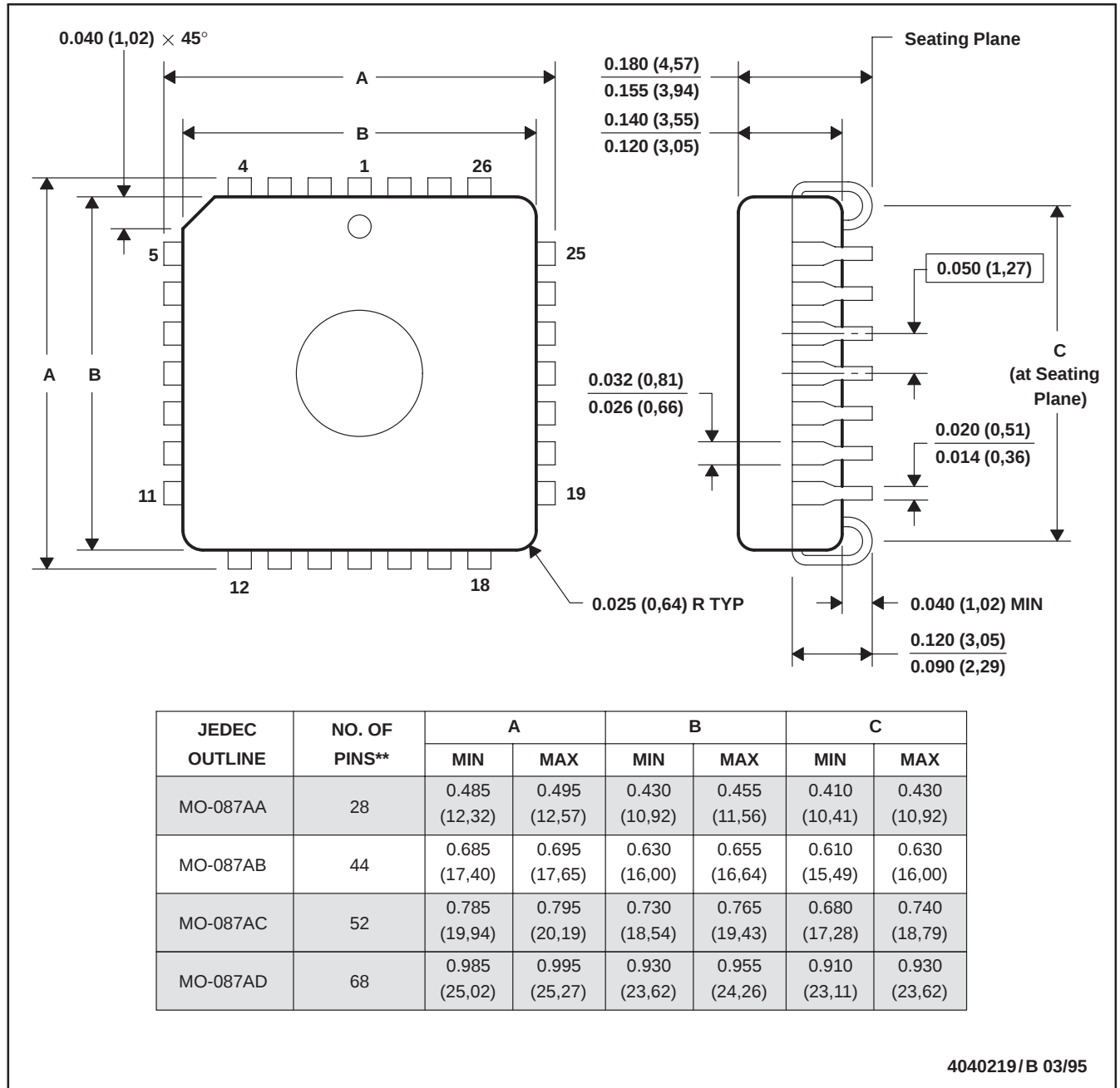
NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS-018

MECHANICAL DATA

FZ (S-CQCC-J)**

J-LEADED CERAMIC CHIP CARRIER

28 LEAD SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. This package can be hermetically sealed with a ceramic lid using glass frit.

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